

42 V System Power Supply with Ultra-low Power Watchdog Timer for Automotive Application

No. EC-408-200326

OVERVIEW

The R5114x is a system power supply IC with an ultra-low power watchdog timer (VR + VD + WDT) that has an input voltage range of 3.5 V to 42 V.

KEY BENEFITS

- Consists of a voltage regulator, a voltage detector and a watchdog timer that provides a system power supply, a power supply voltage monitoring and a system malfunction monitoring.
- Equipped with an auto monitoring stop⁽¹⁾ to cease the watchdog timer monitoring at light load.

KEY SPECIFICATIONS

- Input Voltage Range (Absolute Maximum Rating): 3.5 V to 42.0 V (50.0 V)
- Supply Current: Typ. 8.5 μ A
- Protections: Thermal Shutdown, Output Current Limiting, Short-circuit Current Limiting

Voltage Regulator (VR) Section

- Output Voltage Range: 3.3 V to 5.0 V
- Output Voltage Accuracy: $\pm 1.6\%$ ($-40^{\circ}\text{C} \leq T_a \leq 125^{\circ}\text{C}$)
- Output Current: 250 mA

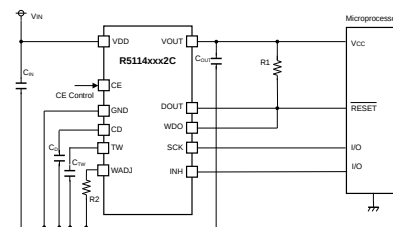
Voltage Detector (VD) Section

- Detection Voltage Threshold Range: 2.5 V to 4.8 V
- Detection Voltage Accuracy: $\pm 1.6\%$ ($-40^{\circ}\text{C} \leq T_a \leq 125^{\circ}\text{C}$)

Watchdog Timer (WDT) Section

- Watchdog Timer Accuracy: -17.8% to 21.7% ($-40^{\circ}\text{C} \leq T_a \leq 125^{\circ}\text{C}$)

TYPICAL APPLICATION



C_{IN} , C_{OUT} : 0.1 μ F, Ceramic capacitor

C_{TW} : Capacitor for setting watchdog timer

C_D : Capacitor for setting reset delay time

SELECTION GUIDE

Product Name	Package	Quantity per Reel
R5114Sxx1*-E2-#E	HSOP-8E	1,000 pcs
R5114Sxx2*-E2-#E	HSOP-18	1,000 pcs
R5114Lxx2*-TR-#E	HQFN0808-28	2,000 pcs

xx: Set Output Voltage (V_{SET}) and Set Detection Voltage ($-V_{DSET}$)

Assign a code starting from 01 to designate a desired combination of V_{SET} and $-V_{DSET}$. Refer to *Product-specific Electrical Characteristics* for detailed information.

#: Other Functions

#	Package	WADJ	WDO Pin	RESETB/DOUT Pin
A	HSOP-8E	Internally Fixed	No	RESETB
B	HSOP-8E	No	No	RESETB
C	HSOP-18 HQFN0808-28	Adjustable	Yes	DOUT

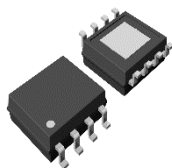
#: Select the quality class

#	Operating Temp. Range	Test Temp.
A	-40°C to 125°C	25 $^{\circ}\text{C}$, High
K	-40°C to 125°C	Low, 25 $^{\circ}\text{C}$, High

APPLICATIONS

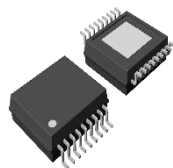
- Microprocessor-based Electronic Equipment for Automotive Applications
- Electric Vehicle (EV) Inverters and Charge Controllers

PACKAGES



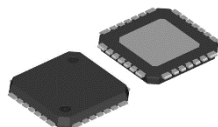
HSOP-8E

5.2 x 6.2 x 1.6* mm
*maximum dimension



HSOP-18

5.2 x 6.2 x 1.6* mm
*maximum dimension



HQFN0808-28

8.8 x 8.8 x 0.95 mm

⁽¹⁾ R5114Sxx1A, R5114xxx2C only

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SELECTION GUIDE

A set detection voltage, a package type, a WADJ function, a WDO pin and a RESETB/DOUT pin are user-selectable options.

Selection Guide

Product Name	Package	Quantity per Reel	Pb Free	Halogen Free
R5114Sxx1*-E2-#E	HSOP-8E	1,000 pcs	Yes	Yes
R5114Sxx2*-E2-#E	HSOP-18	1,000 pcs	Yes	Yes
R5114Lxx2*-TR-#E	HQFN0808-28	2,000 pcs	Yes	Yes

xx: Set Output Voltage (V_{SET}) and Set Detection Voltage ($-V_{DSET}$)

Assign a code starting from 01 to designate a desired combination of V_{SET} and $-V_{DSET}$.

Refer to *Product-specific Electrical Characteristics* for detailed information.

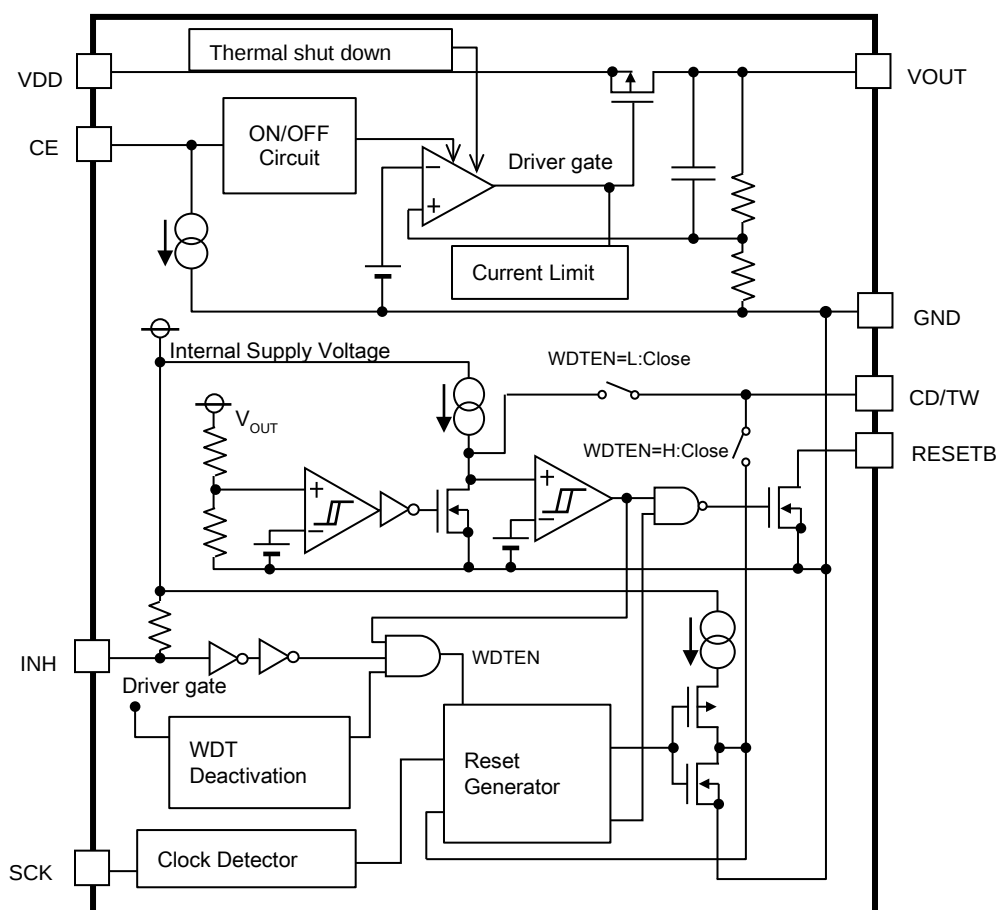
*: Other Functions

*	Package	WDT Type	WADJ Function	WDO Pin	RESETB/DOUT Pin
A	HSOP-8E	Timeout	Internally Fixed	No	RESETB
B	HSOP-8E	Timeout	No	No	RESETB
C	HSOP-18 HQFN0808-28	Timeout	Adjustable	Yes	DOUT

#: Select the quality class

#	Operating Temp. Range	Test Temp.
A	-40°C to 125°C	25°C, High
K	-40°C to 125°C	Low, 25°C, High

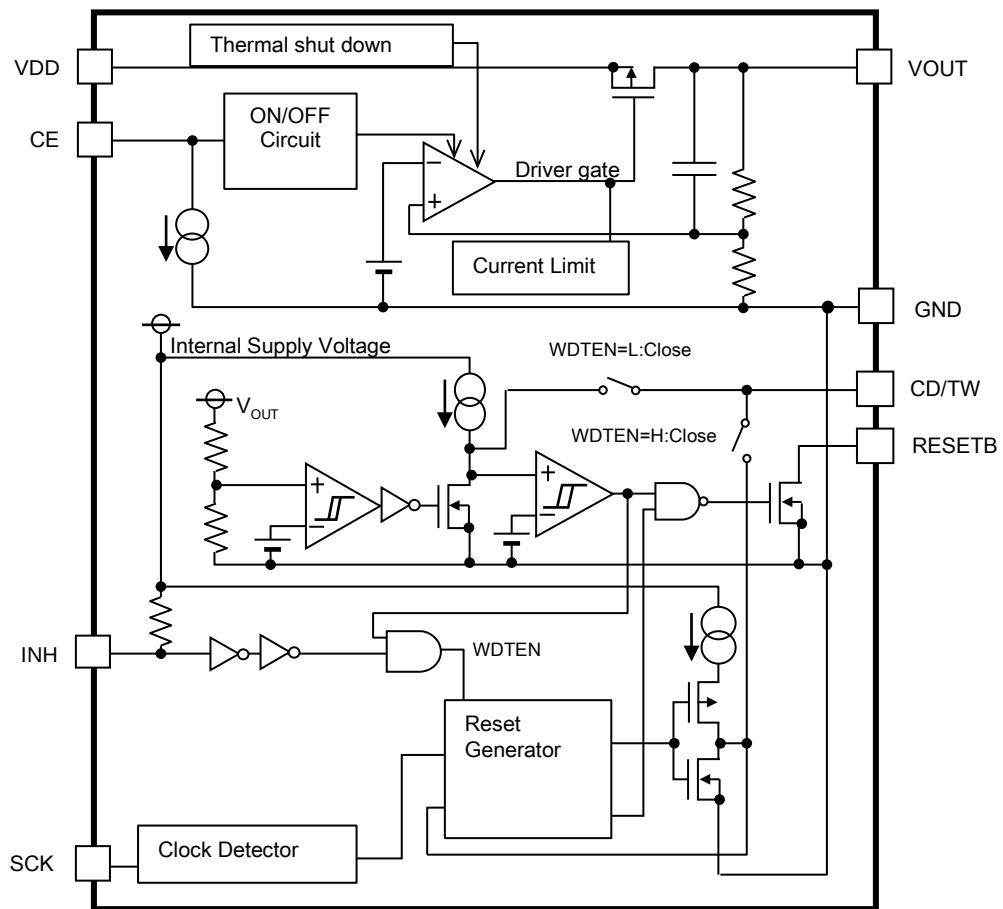
BLOCK DIAGRAMS

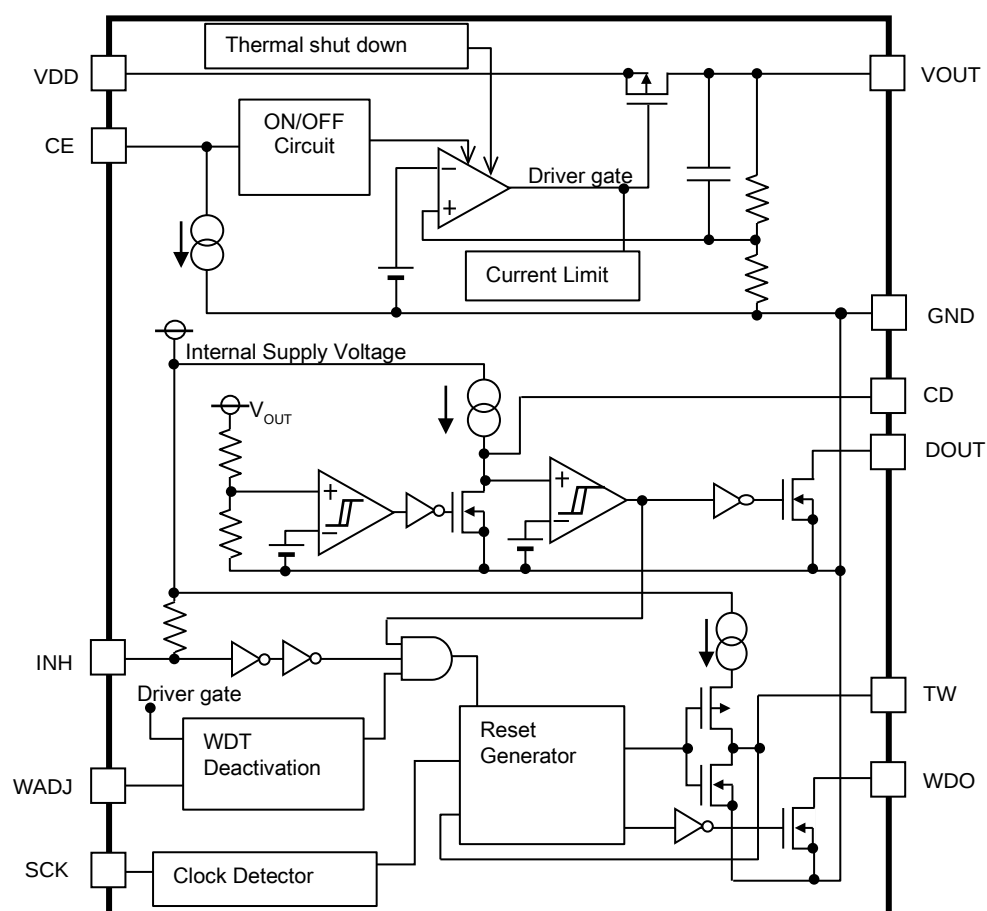


R5114Sxx1A Block Diagram

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**R5114Sxx1B Block Diagram**



R5114xxx2C Block Diagram

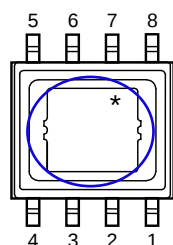
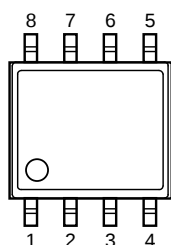
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PIN DESCRIPTION

Top View

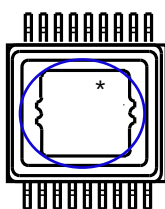
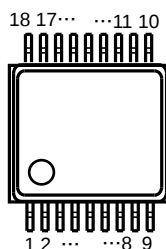
Bottom View



HSOP-8E Pin Configuration

Top View

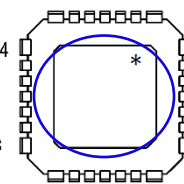
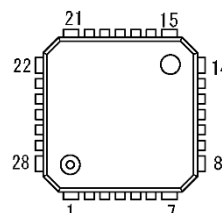
Bottom View



HSOP-18 Pin Configuration

Top View

Bottom View



HQFN0808-28 Pin Configuration

* The tab on the bottom of the package shown by blue circle is a substrate potential (GND). It is recommended that this tab be connected to the ground plane on the board but it is possible to leave the tab floating.

HSOP-8E Pin Description, R5114Sxx1A/R5114Sxx1B

Pin No.	Pin Name	Description
1	VDD	Power Supply Pin
2	TW/CD	Watchdog Timer Monitoring Time Setting Pin/ Voltage Detector Reset Delay Time (Power-on Reset Time) Setting Pin
3	CE	Chip Enable Pin, Active-high
4	GND	Ground Pin
5	INH	Inhibit Pin, Active-low
6	SCK	Watchdog Timer Pulse Inputting Pin
7	RESETB ⁽¹⁾	Reset Output Pin, Active-low, Nch Open Drain Output
8	VOOUT	Voltage Regulator Output Pin

⁽¹⁾ The RESET pin voltage should be pulled up to the appropriate level using an external resistor.

HSOP-18 Pin Description, R5114Sxx2C

Pin No.	Pin Name	Description
1	VDD	Power Supply Pin
2	NC	No Connection
3	CD	Voltage Detector Reset Delay Time (Power-on Reset Time) Setting Pin
4	NC	No Connection
5	TW	Watchdog Timer Monitoring Time Setting Pin
6	NC	No Connection
7	CE	Chip Enable Pin, Active-high
8	NC	No Connection
9	GND	Ground Pin
10	WADJ	Watchdog Timer Operating Threshold Pin
11	INH	Inhibit Pin, Active-low
12	NC	No Connection
13	SCK	Watchdog Timer Pulse Input Pin
14	NC	No Connection
15	WDO ⁽¹⁾	Watchdog Timer Output Pin, Nch Open Drain Output
16	DOUT ⁽²⁾	RESET Output Pin, Active-low, Nch Open Drain Output
17	NC	No Connection
18	VOUT	Voltage Regulator Output Pin

⁽¹⁾ The WDO pin voltage should be pulled up to the appropriate level using an external resistor.

⁽²⁾ The DOUT pin voltage should be pulled up to the appropriate level using an external resistor.

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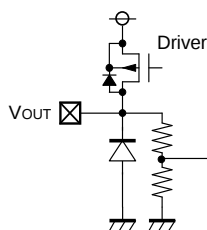
No. EC-408-200326

HQFN0808-28 Pin Description, R5114Lxx2C

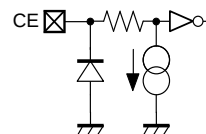
Pin No.	Pin Name	Description
1	GND	Ground Pin
2	CD	Voltage Detector Reset Delay Time (Power-on Reset Time) Setting Pin
3	TW	Watchdog Timer Monitoring Time Setting Pin
4	NC	No Connection
5	CE	Chip Enable Pin, Active-high
6	NC	No Connection
7	GND	Ground Pin
8	GND	Ground Pin
9	GND	Ground Pin
10	NC	No Connection
11	WADJ	Watchdog Timer Operating Threshold Pin
12	INH	Inhibit Pin, Active-low
13	NC	No Connection
14	GND	Ground Pin
15	GND	Ground Pin
16	SCK	Watchdog Timer Pulse Input Pin
17	NC	No Connection
18	WDO ⁽¹⁾	Watchdog Timer Output Pin, Nch Open Drain Output
19	DOUT ⁽²⁾	RESET Output Pin, Active-low, Nch Open Drain Output
20	NC	No Connection
21	GND	Ground Pin
22	GND	Ground Pin
23	NC	No Connection
24	VOUT	Voltage Regulator Output Pin
25	NC	No Connection
26	VDD	Power Supply Pin
27	NC	No Connection
28	GND	Ground Pin

⁽¹⁾ The WDO pin voltage should be pulled up to the appropriate level using an external resistor.⁽²⁾ The DOUT pin voltage should be pulled up to the appropriate level using an external resistor.

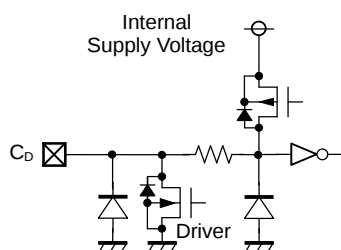
Equivalent Circuits of Individual Pins



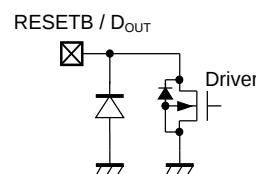
Equivalent Circuit for VOUT Pin



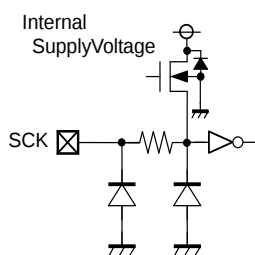
Equivalent Circuit for CE Pin



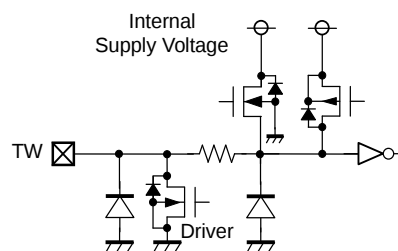
Equivalent Circuit for CD Pin



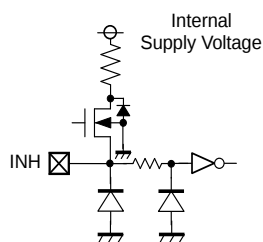
Equivalent Circuit for RESETB Pin (R5114Sxx1x)/
Equivalent Circuit for DOUT Pin (R5114xxx2C)



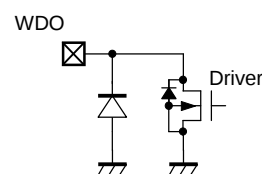
Equivalent Circuit for SCK Pin



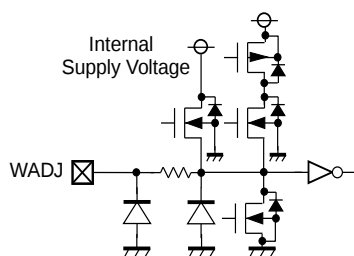
Equivalent Circuit for TW Pin



Equivalent Circuit for INH Pin



Equivalent Circuit for WDO Pin (R5114xxx2C)



Equivalent Circuit for WADJ Pin (R5114xxx2C)

ABSOLUTE MAXIMUM RATINGS

Absolute Maximum Ratings

Symbol	Parameter	Rating	Unit
V_{IN}	Input Voltage	−0.3 to 50	V
	Peak Voltage ⁽¹⁾	60	V
V_{CE}	CE Pin Input Voltage	−0.3 to 50	V
V_{OUT}	VOUT Pin Output Voltage	−0.3 to $V_{IN} + 0.3 \leq 50$	V
V_{CD}	CD Pin Output Voltage	−0.3 to 7.0	V
V_{TW}	TW Pin Output Voltage	−0.3 to 7.0	V
V_{RESETB}	RESETB Pin Output Voltage	−0.3 to 7.0	V
V_{DOUT}	DOUT Pin Output Voltage	−0.3 to 7.0	V
V_{WDO}	WDO Pin Output Voltage	−0.3 to 7.0	V
V_{SCK}	SCK Pin Input Voltage	−0.3 to 7.0	V
V_{INH}	INH Pin Input Voltage	−0.3 to 7.0	V
V_{WADJ}	WADJ Pin Output Voltage	−0.3 to 7.0	V
I_{RESETB}	RESETB Pin Current	16	mA
I_{DOUT}	DOUT Pin Current	16	mA
I_{WDO}	WDO Pin Current	16	mA
P_D	Power Dissipation	Refer to Appendix “Power Dissipation”	
T_j	Junction Temperature Range	−40 to 150	°C
T_{stg}	Storage Temperature Range	−55 to 150	°C

ABSOLUTE MAXIMUM RATINGS

Electronic and mechanical stress momentarily exceeded absolute maximum ratings may cause permanent damage and may degrade the life time and safety for both device and system using the device in the field. The functional operation at or over these absolute maximum ratings are not assured.

⁽¹⁾ Application time is 200 ms or less.

RECOMMENDED OPERATING CONDITIONS

Recommended Operating Conditions

Symbol	Parameter	Rating	Unit
V _{IN}	Input Voltage	3.5 to 42.0	V
V _{CE}	CE Pin Input Voltage	0 to 42.0	V
V _{SCK}	SCK Pin Input Voltage	0 to 5.5	V
V _{INH}	INH Pin Input Voltage	0 to 5.5	V
T _a	Operating Temperature Range	−40 to 125	°C

RECOMMENDED OPERATING CONDITIONS
All of electronic equipment should be designed that the mounted semiconductor devices operate within the recommended operating conditions. The semiconductor devices cannot operate normally over the recommended operating conditions, even if they are used over such conditions by momentary electronic noise or surge. And the semiconductor devices may receive serious damage when they continue to operate over the recommended operating conditions.

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ELECTRICAL CHARACTERISTICS

$C_{IN} = C_{OUT} = 0.1\mu F$, $V_{IN} = 14 V$, unless othrewise noted.

The specifications surrounded by are guaranteed by design engineering at $-40^{\circ}C \leq T_a \leq 125^{\circ}C$.

R5114xxxxx-AE Electrical Characteristics

($T_a = 25^{\circ}C$)

Symbol	Parameter	Test Conditions/Comments	Min.	Typ.	Max.	Unit
I_{SS}	Supply Current	$I_{OUT} = 0 \text{ mA}$ R5114Sxx1A/ R5114xxx2C		8.5	18	μA
		$I_{OUT} = 0 \text{ mA}$ R5114Sxx1B		13.5	23	μA
$I_{standby}$	Standby Current	$V_{IN} = 42 V$, $V_{CE} = 0 V$		0.2	1.0	μA
I_{PD}	CE Pull-down Constant Current	$V_{CE} = 42 V$		0.2	0.6	μA
V_{CEH}	CE Input Voltage, High		2.2		42	V
V_{CEL}	CE Input Voltage, Low				1.0	V

VR Section

($T_a = 25^{\circ}C$)

Symbol	Parameter	Test Conditions/Comments	Min.	Typ.	Max.	Unit
V_{OUT}	Output Voltage	$I_{OUT} = 1 \text{ mA}$ $T_a = 25^{\circ}C$	$\times 0.994$		$\times 1.006$	V
		$-40^{\circ}C \leq T_a \leq 125^{\circ}C$	$\times 0.984$		$\times 1.016$	V
$\Delta V_{OUT}/\Delta I_{OUT}$	Load Regulation	$V_{IN} = V_{SET} + 3.0 V$ $1 \text{ mA} \leq I_{OUT} \leq 250 \text{ mA}$	-20	0	50	mV
V_{DIF}	Dropout Voltage	$I_{OUT} = 250 \text{ mA}$ $V_{SET} = 3.3$		1.0	2.0	V
		$V_{SET} = 5.0$		0.80	1.5	V
$\Delta V_{OUT}/\Delta V_{IN}$	Line Regulation	$3.5 V \leq V_{SET} + 0.5 V \leq V_{IN} \leq 42 V$ $I_{OUT} = 1 \text{ mA}$		0.01	0.02	%/V
I_{LIM}	Output Current Limit	$V_{IN} = V_{SET} + 3.0 V$	320	440	530	mA
I_{SC}	Short-circuit Current Limit	$V_{IN} = 5 V$, $V_{OUT} = 0 V$	70	95	135	mA
T_{TSD}	Thermal Shutdown Temperature Threshold, rising	Junction Temperature	150	170		$^{\circ}C$
T_{TSR}	Thermal Shutdown Temperature Threshold, falling	Junction Temperature	125	140		$^{\circ}C$

$C_{IN} = C_{OUT} = 0.1\mu F$, $V_{IN} = 14\text{ V}$, unless othrewise noted.

The specifications surrounded by are guaranteed by design engineering at $-40^{\circ}\text{C} \leq T_a \leq 125^{\circ}\text{C}$.

R5114xxxxx-AE Electrical Characteristics (Continued)

VD Section

($T_a = 25^{\circ}\text{C}$)

Symbol	Parameter	Test Conditions/Comments		Min.	Typ.	Max.	Unit
$-V_{DET}$	Detection Voltage	$V_{DD} = V_{OUT}$ (V_{OUT} Detection)	$T_a = 25^{\circ}\text{C}$	x0.994		x1.006	V
			$-40^{\circ}\text{C} \leq T_a \leq 125^{\circ}\text{C}$	x0.984		x1.016	
V_{HYS}	Detection Threshold Hysteresis			$\frac{-V_{DSET}}{x0.015}$	$\frac{-V_{DSET}}{x0.02}$	$\frac{-V_{DSET}}{x0.025}$	V
t_{RESET}	Reset Delay Time (Power-on Reset)	$C_D = 0.22\mu F$		184	220	253	ms
V_{RESETB}	RESETB Pull-up Voltage	R5114Sxx1A / R5114Sxx1B				5.5	V
V_{DOUT}	DOUT Pull-up Voltage	R5114xxx2C				5.5	V
$I_{OUTRSTB}$	Nch Driver Output Current (RESETB Output Pin)	R5114Sxx1A / R5114Sxx1B $V_{IN} = 3.5\text{ V}$, $V_{RESETB} = 0.1\text{ V}$		0.3	0.6		mA
$I_{LEAKRSTB}$	Nch Driver Leakage Current (RESETB Output Pin)	R5114Sxx1A / R5114Sxx1B $V_{RESETB} = 5.5\text{ V}$				0.3	μA
$I_{OUTDOUT}$	Nch Driver Output Current (DOUT Output Pin)	R5114xxx2C $V_{IN} = 3.5\text{ V}$, $V_{DOUT} = 0.1\text{ V}$		0.3	0.6		mA
$I_{LEAKDOUT}$	Nch Driver Leakage Current (DOUT Output Pin)	R5114xxx2C $V_{DOUT} = 5.5\text{ V}$				0.3	μA
R_{LCD}	CD Auto-discharge (Nch Tr. On-resistance)	$V_{CE} = 0\text{ V}$, $V_{CD} = 0.1\text{ V}$			7.5	20	k Ω

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$C_{IN} = C_{OUT} = 0.1\mu F$, $V_{IN} = 14 V$, unless othrewise noted.

The specifications surrounded by are guaranteed by design engineering at $-40^{\circ}C \leq T_a \leq 125^{\circ}C$.

R5114xxxxx-AE Electrical Characteristics (Continued)

WDT Section

($T_a = 25^{\circ}C$)

Symbol	Parameter	Test Conditions/Comments	Min.	Typ.	Max.	Unit
t_{IGN}	Pulse Ignoring Time	$C_{TW} = 10 nF$	14.0	18.0	22.9	ms
t_{WD}	Monitoring Time	$C_{TW} = 10nF$	14.8	18.0	21.9	ms
t_{WR}	Reset Time	$C_{TW} = 10 nF$	7.2	9.0	10.7	ms
V_{SCKH}	SCK Input, High		1.5		5.5	V
V_{SCKL}	SCK Input, Low		0		0.65	V
V_{INHH}	INH Input, High		1.5		5.5	V
V_{INHL}	INH Input, Low		0		0.5	V
I_{INH}	INH Pull-up Current	$V_{INH} = 0 V$	4.0	8.0	11.5	μA
$I_{OWDTACT}$	WDT Activating Threshold Current	R5114Sxx1A		1.2	2.2	mA
$I_{OWDTDEACT}$	WDT Deactivating Threshold Current	R5114Sxx1A	0.6	1.0		mA
$\frac{I_{OUT}}{I_{WADJ}}$ (1)	WADJ Pin Current Ratio (WDT is not active.)	R5114xxx2C $V_{WADJ} = 0 V$, $I_{OUT} = 10 mA$	1000	1600	3200	-
$\frac{I_{OUT}}{I_{WADJ}}$ (2)	WADJ Pin Current Ratio (WDT is active.)	R5114xxx2C $V_{WADJ}=1.0 V$, $I_{OUT} = 10 mA$	800	1200	2400	-
V_{WADJ_TH}	WADJ Pin Threshold Voltage	R5114xxx2C	0.6	0.7	0.8	V
t_{SCKWH}	SCK Minimum Input Pulse Width, High	$V_{SCKL} = 0.5$, $V_{SCKH} = 1.6$	500			ns
t_{SCKWL}	SCK Minimum Input Pulse Width, Low	$V_{SCKL} = 0.5$, $V_{SCKH} = 1.6$	1500			ns
V_{WDO}	WDO Pull-up Voltage				5.5	V
I_{OUTWDO}	Nch Driver Output Current (WDO Output Pin)	R5114xxx2C $V_{IN} = 3.5 V$, $V_{WDO} = 0.1 V$	0.7	1.5		mA
$I_{LEAKWDO}$	Nch Driver Leakage Current (WDO Output Pin)	R5114xxx2C $V_{WDO} = 5.5 V$			0.3	μA
R_{LTW}	C_{TW} Auto-discharge (Nch Tr. On-resistance)	$V_{CE} = 0 V$, $V_{TW} = 0.1 V$		7.5	20	k Ω

R5114xxxxx-AE

The specifications surrounded by are guaranteed by design engineering at $-40^{\circ}\text{C} \leq T_a \leq 125^{\circ}\text{C}$.

Product-specific Electrical Characteristics: Voltage Regulator Section

Product Name	Voltage Regulator Section					
	V_{OUT}					
	$T_a = 25^{\circ}\text{C}$			$-40 \leq T_a \leq 125^{\circ}\text{C}$		
	Min	Typ.	Max.	Min.	Typ.	Max.
R5114x01xx	4.9700	5.000	5.0300	4.9200	5.000	5.0800
R5114x02xx	4.9700	5.000	5.0300	4.9200	5.000	5.0800
R5114x03xx	4.9700	5.000	5.0300	4.9200	5.000	5.0800
R5114x04xx	4.9700	5.000	5.0300	4.9200	5.000	5.0800
R5114x05xx	3.2802	3.300	3.3198	3.2472	3.300	3.3528
R5114x06xx	3.2802	3.300	3.3198	3.2472	3.300	3.3528
R5114x07xx	3.2802	3.300	3.3198	3.2472	3.300	3.3528
R5114x08xx	4.9700	5.000	5.0300	4.9200	5.000	5.0800
R5114x09xx	4.9700	5.000	5.0300	4.9200	5.000	5.0800
R5114x10xx	4.9700	5.000	5.0300	4.9200	5.000	5.0800
R5114x11xx	4.9700	5.000	5.0300	4.9200	5.000	5.0800
R5114x12xx	4.9700	5.000	5.0300	4.9200	5.000	5.0800

Product-specific Electrical Characteristics: Voltage Detector Section

Product Name	Voltage Detector Section								
	$-V_{\text{DET}}$						V_{HYS}		
	$T_a = 25^{\circ}\text{C}$			$-40 \leq T_a \leq 125^{\circ}\text{C}$					
	Min.	Typ.	Max.	Min.	Typ.	Max.	Min.	Typ.	Max.
R5114x01xx	4.5724	4.600	4.6276	4.5264	4.600	4.6736	0.0690	0.0920	0.1150
R5114x02xx	3.2802	3.300	3.3198	3.2472	3.300	3.3528	0.0495	0.0660	0.0825
R5114x03xx	3.9760	4.000	4.0240	3.9360	4.000	4.0640	0.0600	0.0800	0.1000
R5114x04xx	4.4730	4.500	4.5270	4.4280	4.500	4.5720	0.0675	0.0900	0.1125
R5114x05xx	2.9820	3.000	3.0180	2.9520	3.000	3.0480	0.0450	0.0600	0.0750
R5114x06xx	2.8826	2.900	2.9174	2.8536	2.900	2.9464	0.0435	0.0580	0.0725
R5114x07xx	2.6838	2.700	2.7162	2.6568	2.700	2.7432	0.0405	0.0540	0.0675
R5114x08xx	4.3736	4.400	4.4264	4.3296	4.400	4.4704	0.0660	0.0880	0.1100
R5114x09xx	4.0754	4.100	4.1246	4.0344	4.100	4.1656	0.0615	0.0820	0.1025
R5114x10xx	4.1748	4.200	4.2252	4.1328	4.200	4.2672	0.0630	0.0840	0.1050
R5114x11xx	2.4850	2.500	2.5150	2.4600	2.500	2.5400	0.0375	0.0500	0.0625
R5114x12xx	2.7832	2.800	2.8168	2.7552	2.800	2.8448	0.0420	0.0560	0.0700

R5114x

No. EC-408-200326

 $C_{IN} = C_{OUT} = 0.1\mu F$, $V_{IN} = 14\text{ V}$, unless othrewise noted.**R5114xxxxx-KE Electrical Characteristics****($-40^{\circ}\text{C} \leq T_a \leq 125^{\circ}\text{C}$)**

Symbol	Parameter	Test Conditions/Comments	Min.	Typ.	Max.	Unit
I_{SS}	Supply Current	$I_{OUT} = 0\text{ mA}$ R5114Sxx1A/ R5114xxx2C		8.5	18	μA
		$I_{OUT} = 0\text{ mA}$ R5114Sxx1B		13.5	23	μA
$I_{standby}$	Standby Current	$V_{IN} = 42\text{ V}$, $V_{CE} = 0\text{ V}$		0.2	1.0	μA
I_{PD}	CE Pull-down Constant Current	$V_{CE} = 42\text{ V}$		0.2	0.6	μA
V_{CEH}	CE Input Voltage, High		2.2		42	V
V_{CEL}	CE Input Voltage, Low				1.0	V

VR Section**($-40^{\circ}\text{C} \leq T_a \leq 125^{\circ}\text{C}$)**

Symbol	Parameter	Test Conditions/Comments	Min.	Typ.	Max.	Unit
V_{OUT}	Output Voltage	$I_{OUT} = 1\text{ mA}$ $T_a = 25^{\circ}\text{C}$	$\times 0.994$		$\times 1.006$	V
		$-40^{\circ}\text{C} \leq T_a \leq 125^{\circ}\text{C}$	$\times 0.984$		$\times 1.016$	V
$\Delta V_{OUT}/\Delta I_{OUT}$	Load Regulation	$V_{IN} = V_{SET} + 3.0\text{ V}$ $1\text{ mA} \leq I_{OUT} \leq 250\text{ mA}$	-20	0	50	mV
V_{DIF}	Dropout Voltage	$I_{OUT} = 250\text{ mA}$ $V_{SET} = 3.3$		1.0	2.0	V
		$V_{SET} = 5.0$		0.80	1.5	V
$\Delta V_{OUT}/\Delta V_{IN}$	Line Regulation	$3.5\text{ V} \leq V_{SET} + 0.5\text{ V} \leq V_{IN} \leq 42\text{ V}$ $I_{OUT} = 1\text{ mA}$		0.01	0.02	%/V
I_{LIM}	Output Current Limit	$V_{IN} = V_{SET} + 3.0\text{ V}$	320	440	530	mA
I_{SC}	Short-circuit Current Limit	$V_{IN} = 5\text{ V}$, $V_{OUT} = 0\text{ V}$	70	95	135	mA
T_{TSD}	Thermal Shutdown Temperature Threshold, rising	Junction Temperature	150	170		$^{\circ}\text{C}$
T_{TSR}	Thermal Shutdown Temperature Threshold, falling	Junction Temperature	125	140		$^{\circ}\text{C}$

$C_{IN} = C_{OUT} = 0.1\mu F$, $V_{IN} = 14 V$, unless othrewise noted.

R5114xxxxx-KE Electrical Characteristics (Continued)

VD Section

($-40^{\circ}C \leq T_a \leq 125^{\circ}C$)

Symbol	Parameter	Test Conditions/Comments		Min.	Typ.	Max.	Unit
$-V_{DET}$	Detection Voltage	$V_{DD} = V_{OUT}$ (V_{OUT} Detection)	$T_a = 25^{\circ}C$	x0.994		x1.006	V
			$-40^{\circ}C \leq T_a \leq 125^{\circ}C$	x0.984		x1.016	
V_{HYS}	Detection Threshold Hysteresis			$-V_{DSET}$ x0.015	$-V_{DSET}$ x0.02	$-V_{DSET}$ x0.025	V
t_{RESET}	Reset Delay Time (Power-on Reset)	$C_D = 0.22 \mu F$		184	220	253	ms
V_{RESETB}	RESETB Pull-up Voltage	R5114Sxx1A / R5114Sxx1B				5.5	V
V_{DOUT}	DOUT Pull-up Voltage	R5114xxx2C				5.5	V
$I_{OUTRSTB}$	Nch Driver Output Current (RESETB Output Pin)	R5114Sxx1A / R5114Sxx1B $V_{IN} = 3.5 V$, $V_{RESETB} = 0.1 V$		0.3	0.6		mA
$I_{LEAKRSTB}$	Nch Driver Leakage Current (RESETB Output Pin)	R5114Sxx1A / R5114Sxx1B $V_{RESETB} = 5.5 V$				0.3	μA
$I_{OUTDOUT}$	Nch Driver Output Current (DOUT Output Pin)	R5114xxx2C $V_{IN} = 3.5 V$, $V_{DOUT} = 0.1 V$		0.3	0.6		mA
$I_{LEAKDOUT}$	Nch Driver Leakage Current (DOUT Output Pin)	R5114xxx2C $V_{DOUT} = 5.5 V$				0.3	μA
R_{LCD}	CD Auto-discharge (Nch Tr. On-resistance)	$V_{CE} = 0 V$, $V_{CD} = 0.1 V$			7.5	20	k Ω

R5114x

No. EC-408-200326

 $C_{IN} = C_{OUT} = 0.1\mu F$, $V_{IN} = 14\text{ V}$, unless othrewise noted.**R5114xxxxx-KE Electrical Characteristics (Continued)****WDT Section****($-40^{\circ}\text{C} \leq T_a \leq 125^{\circ}\text{C}$)**

Symbol	Parameter	Test Conditions/Comments	Min.	Typ.	Max.	Unit
t_{IGN}	Pulse Ignoring Time	$C_{TW} = 10\text{ nF}$	14.0	18.0	22.9	ms
t_{WD}	Monitoring Time	$C_{TW} = 10\text{ nF}$	14.8	18.0	21.9	ms
t_{WR}	Reset Time	$C_{TW} = 10\text{ nF}$	7.2	9.0	10.7	ms
V_{SCKH}	SCK Input, High		1.5		5.5	V
V_{SCKL}	SCK Input, Low		0		0.65	V
V_{INHH}	INH Input, High		1.5		5.5	V
V_{INHL}	INH Input, Low		0		0.5	V
I_{INH}	INH Pull-up Current	$V_{INH} = 0\text{ V}$	4.0	8.0	11.5	μA
$I_{OWDTACT}$	WDT Activating Threshold Current	R5114Sxx1A		1.2	2.2	mA
$I_{OWDTDEACT}$	WDT Deactivating Threshold Current	R5114Sxx1A	0.6	1.0		mA
$\frac{I_{OUT}}{I_{WADJ}}$ (1)	WADJ Pin Current Ratio (WDT is not active.)	R5114xxx2C $V_{WADJ} = 0\text{ V}$, $I_{OUT} = 10\text{ mA}$	1000	1600	3200	-
$\frac{I_{OUT}}{I_{WADJ}}$ (2)	WADJ Pin Current Ratio (WDT is active.)	R5114xxx2C $V_{WADJ} = 1.0\text{ V}$, $I_{OUT} = 10\text{ mA}$	800	1200	2400	-
V_{WADJ_TH}	WADJ Pin Threshold Voltage	R5114xxx2C	0.6	0.7	0.8	V
t_{SCKWH}	SCK Minimum Input Pulse Width, High	$V_{SCKL} = 0.5$, $V_{SCKH} = 1.6$	500			ns
t_{SCKWL}	SCK Minimum Input Pulse Width, Low	$V_{SCKL} = 0.5$, $V_{SCKH} = 1.6$	1500			ns
V_{WDO}	WDO Pull-up Voltage				5.5	V
I_{OUTWDO}	Nch Driver Output Current (WDO Output Pin)	R5114xxx2C $V_{IN} = 3.5\text{ V}$, $V_{WDO} = 0.1\text{ V}$	0.7	1.5		mA
$I_{LEAKWDO}$	Nch Driver Leakage Current (WDO Output Pin)	R5114xxx2C $V_{WDO} = 5.5\text{ V}$			0.3	μA
R_{LTW}	C_{TW} Auto-discharge (Nch Tr. On-resistance)	$V_{CE} = 0\text{ V}$, $V_{TW} = 0.1\text{ V}$		7.5	20	k Ω

R5114xxxxx-KE

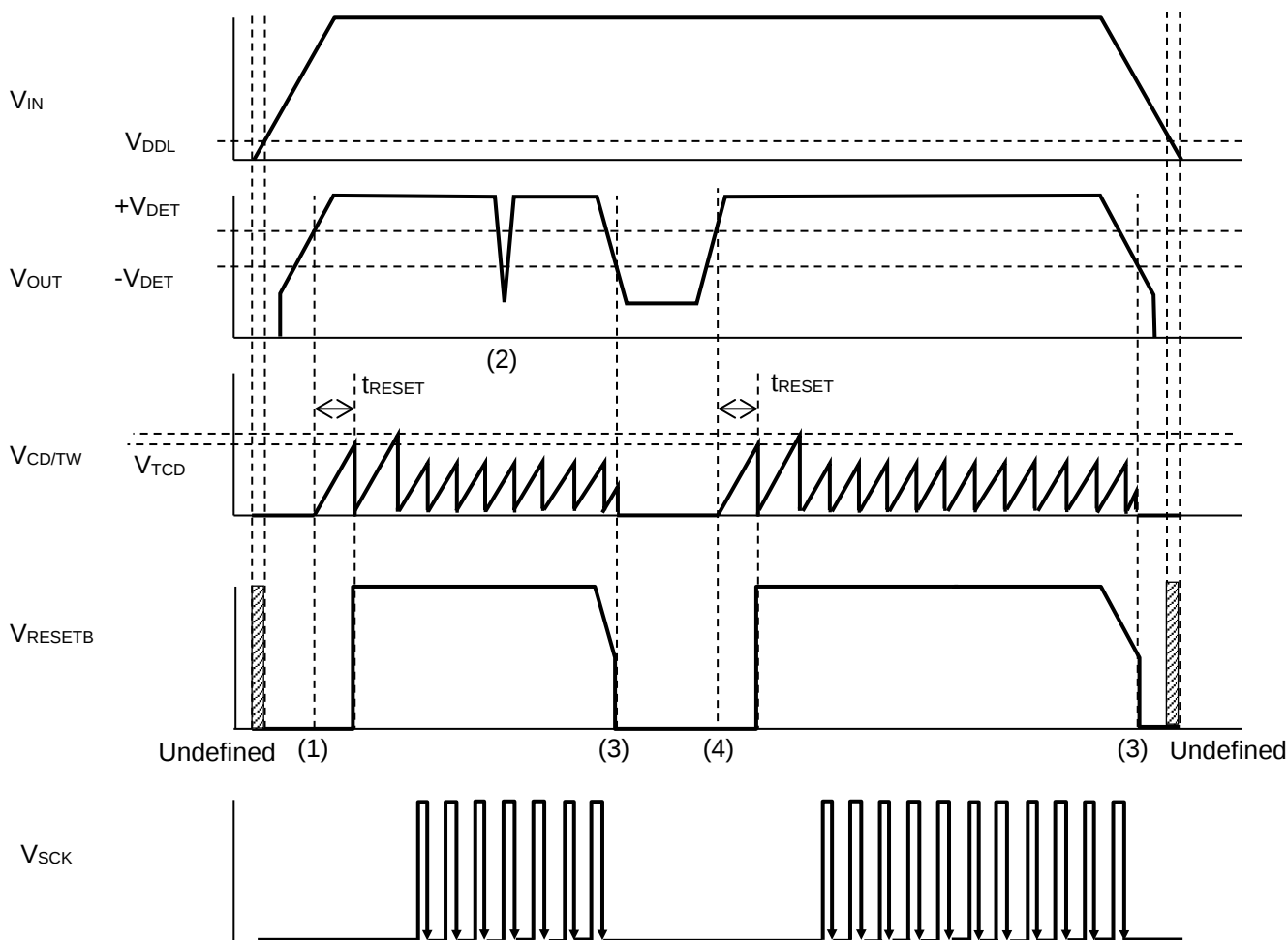
Product-specific Electrical Characteristics: Voltage Regulator Section

Product Name	Voltage Regulator Section					
	V_{OUT}					
	$T_a = 25^{\circ}\text{C}$			$-40 \leq T_a \leq 125^{\circ}\text{C}$		
	Min.	Typ.	Max.	Min.	Typ.	Max.
R5114x01xx	4.9700	5.000	5.0300	4.9200	5.000	5.0800
R5114x02xx	4.9700	5.000	5.0300	4.9200	5.000	5.0800
R5114x03xx	4.9700	5.000	5.0300	4.9200	5.000	5.0800
R5114x04xx	4.9700	5.000	5.0300	4.9200	5.000	5.0800
R5114x05xx	3.2802	3.300	3.3198	3.2472	3.300	3.3528
R5114x06xx	3.2802	3.300	3.3198	3.2472	3.300	3.3528
R5114x07xx	3.2802	3.300	3.3198	3.2472	3.300	3.3528
R5114x08xx	4.9700	5.000	5.0300	4.9200	5.000	5.0800
R5114x09xx	4.9700	5.000	5.0300	4.9200	5.000	5.0800
R5114x10xx	4.9700	5.000	5.0300	4.9200	5.000	5.0800
R5114x11xx	4.9700	5.000	5.0300	4.9200	5.000	5.0800
R5114x12xx	4.9700	5.000	5.0300	4.9200	5.000	5.0800

Product-specific Electrical Characteristics: Voltage Detector Section

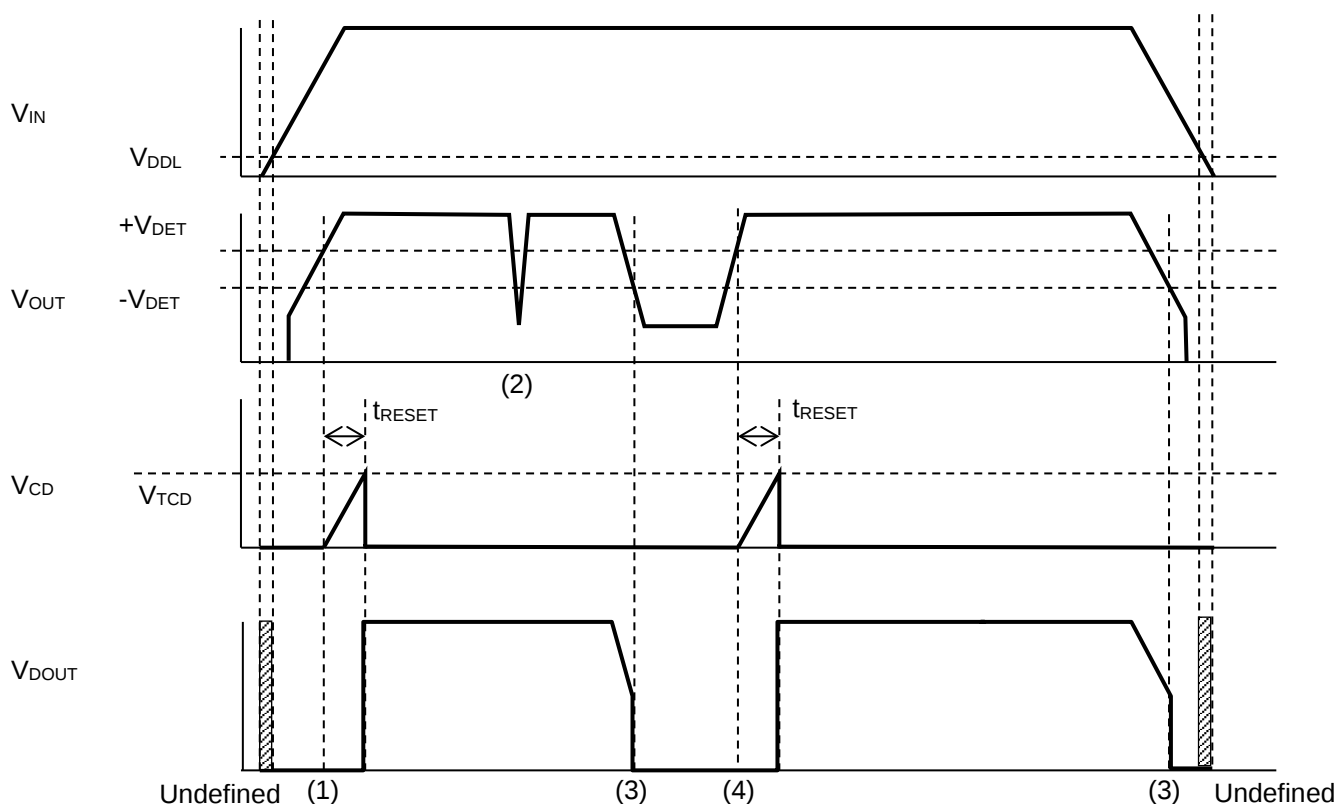
Product Name	Voltage Detector Section								
	$-V_{DET}$						V_{HYS}		
	$T_a = 25^{\circ}\text{C}$			$-40 \leq T_a \leq 125^{\circ}\text{C}$					
	Min.	Typ.	Max.	Min.	Typ.	Max.	Min.	Typ.	Max.
R5114x01xx	4.5724	4.600	4.6276	4.5264	4.600	4.6736	0.0690	0.0920	0.1150
R5114x02xx	3.2802	3.300	3.3198	3.2472	3.300	3.3528	0.0495	0.0660	0.0825
R5114x03xx	3.9760	4.000	4.0240	3.9360	4.000	4.0640	0.0600	0.0800	0.1000
R5114x04xx	4.4730	4.500	4.5270	4.4280	4.500	4.5720	0.0675	0.0900	0.1125
R5114x05xx	2.9820	3.000	3.0180	2.9520	3.000	3.0480	0.0450	0.0600	0.0750
R5114x06xx	2.8826	2.900	2.9174	2.8536	2.900	2.9464	0.0435	0.0580	0.0725
R5114x07xx	2.6838	2.700	2.7162	2.6568	2.700	2.7432	0.0405	0.0540	0.0675
R5114x08xx	4.3736	4.400	4.4264	4.3296	4.400	4.4704	0.0660	0.0880	0.1100
R5114x09xx	4.0754	4.100	4.1246	4.0344	4.100	4.1656	0.0615	0.0820	0.1025
R5114x10xx	4.1748	4.200	4.2252	4.1328	4.200	4.2672	0.0630	0.0840	0.1050
R5114x11xx	2.4850	2.500	2.5150	2.4600	2.500	2.5400	0.0375	0.0500	0.0625
R5114x12xx	2.7832	2.800	2.8168	2.7552	2.800	2.8448	0.0420	0.0560	0.0700

THEORY OF OPERATION



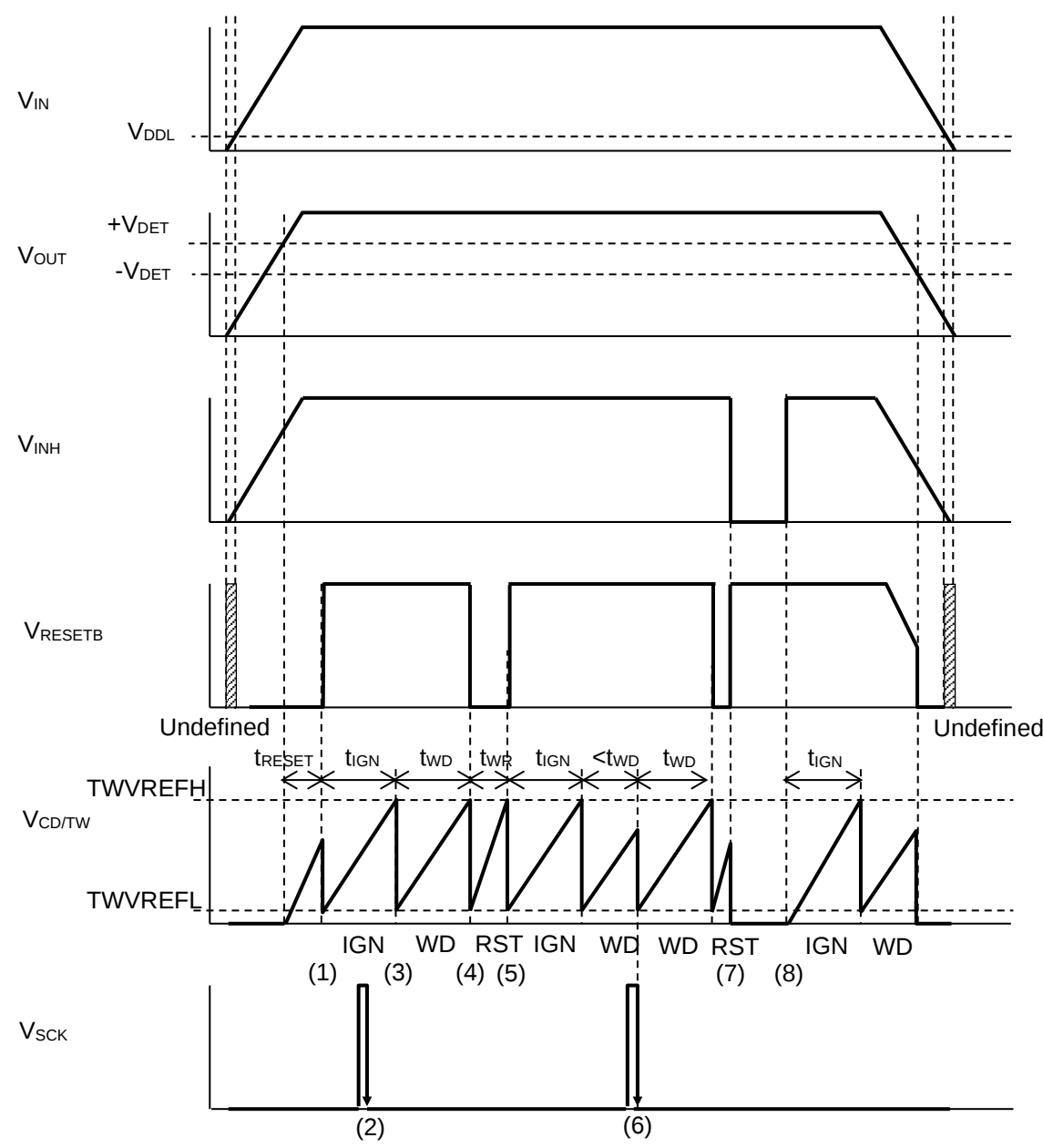
R5114Sxx1A/ R5114Sxx1B VD Timing Chart

- (1) When the output voltage (V_{OUT}) of a voltage regulator (VR) becomes more than the reset voltage ($+V_{DET}$), the RESETB pin voltage (V_{RESETB}) becomes high after the reset delay time (t_{RESET}). During t_{RESET} , the CD/TW pin serves as a rest delay time setting pin. When V_{RESETB} becomes high, the CD/TW pin serves as a watchdog timer setting pin.
- (2) When V_{OUT} becomes lower than the detection voltage ($-V_{DET}$) and when that period is shorter than the delay time (t_{DELAY}), Typ. 30 μ s or lower, V_{RESETB} remains high and does not go into the detecting state.
- (3) When V_{OUT} becomes lower than $-V_{DET}$, V_{RESETB} becomes low after a 30- μ s (Typ.) t_{DELAY} , and the voltage detector (VD) goes into the detecting state.
- (4) When V_{OUT} becomes higher than $+V_{DET}$, V_{RESETB} becomes high after t_{RESET} . (V_{TCD} = Typ.1 V)



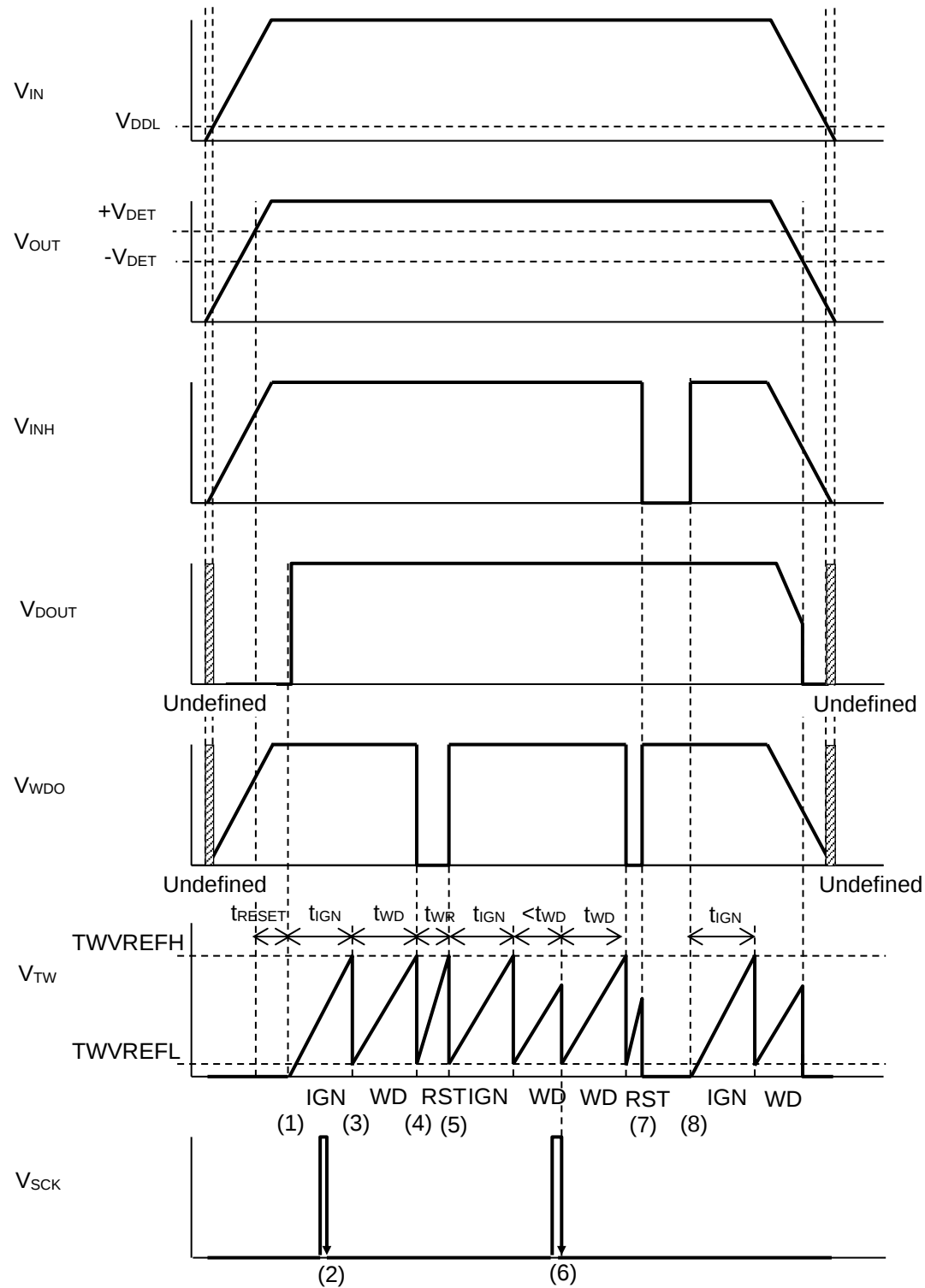
R5114xxx2C VD Timing Chart

- (1) When the output voltage (V_{OUT}) of a voltage regulator (VR) becomes higher than the reset voltage ($+V_{DET}$), the DOUT pin voltage (V_{DOUT}) becomes high after the reset delay time (t_{RESET}).
- (2) When V_{OUT} becomes lower than the detection voltage ($-V_{DET}$) and when that period is shorter than the delay time (t_{DELAY}), Typ. 30 μ s or lower, V_{DOUT} remains high and does not go into the detecting state.
- (3) When V_{OUT} becomes lower than $-V_{DET}$, V_{DOUT} becomes low after a 30- μ s (Typ.) t_{DELAY} , and the voltage detector (VD) goes into the detecting state.
- (4) When V_{OUT} becomes higher than $+V_{DET}$, V_{DOUT} becomes high after t_{RESET} . (V_{TCD} = Typ.1 V)



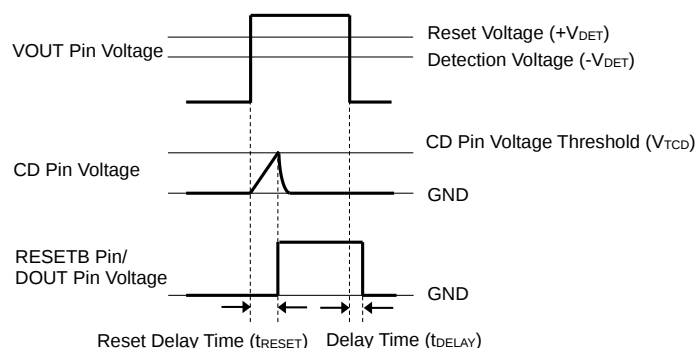
R5114Sxx1A/R5114Sxx1B WDT Timing Chart, Timeout Type

- (1) When the output voltage (V_{OUT}) of a voltage regulator (VR) becomes higher than the reset voltage ($+V_{DET}$), the RESETB pin voltage (V_{RESETB}) becomes high after the reset delay time (t_{RESET}), and the watchdog timer (WDT) starts monitoring a pulse. After that, the CD/TW pin voltage ($V_{CD/TW}$) repeats charge and discharge. As a result, a sawtooth wave is generated. The WDT has three states: Ignoring, Reset and Monitoring. In each state, the CD/TW pin is charged from 0 V or TWVREFL (Typ. 0.08 V).
- (2) After WDT starts, WDT is in an ignoring state until $V_{CD/TW}$ is charged up to TWVREFH (Typ. 2 V). So, a pulse to the SCK pin is ignored during the ignoring state.
- (3) When $V_{CD/TW}$ is charged up to TWVREFH during the ignoring state, the CD/TW pin starts discharging and WDT goes into a monitoring state.
- (4) When a pulse is not sent to the SCK pin before $V_{CD/TW}$ reaches TWVREFH during the monitoring state, the CD/TW pin starts discharging and WDT goes into a reset state. During the reset state, V_{RESETB} becomes low.
- (5) When $V_{CD/TW}$ reaches TWVREFH during the reset state, the CD/TW pin starts discharging and WDT goes into an ignoring state.
- (6) When a pulse is sent to the SCK pin before $V_{CD/TW}$ reaches TWVREFH during the monitoring state, the CD/TW pin starts discharging and WDT goes into an ignoring state.
- (7) When the INH pin voltage (V_{INH}) is set to low, WDT stops monitoring. So, the voltage detector (VD) determines whether V_{RESETB} is set to high/low, or $V_{CD/TW}$ is charged/discharged.
- (8) When V_{INH} is changed from low to high, WDT goes into the ignoring state and restarts monitoring a pulse.



R5114xxx2C WDT Timing Chart, Timeout Type

- (1) When the output voltage (V_{OUT}) of a voltage regulator (VR) becomes higher than the reset voltage ($+V_{DET}$), the DOUT pin voltage (V_{DOUT}) becomes high after the reset delay time (t_{RESET}), and the watchdog timer (WDT) starts monitoring a pulse. After that, the TW pin voltage (V_{TW}) repeats charge and discharge. As a result, a sawtooth wave is generated. WDT has three states: Ignoring, Reset and Monitoring. In each state, the TW pin is charged from 0 V or $TWVREFL$ (Typ. 0.08 V).
- (2) After WDT starts, WDT is in an ignoring state until V_{TW} is charged up to $TWVREFH$ (Typ. 2 V). So, a pulse to the SCK pin is ignored during the ignoring state.
- (3) When V_{TW} is charged up to $TWVREFH$ during the ignoring state, the TW pin starts discharging and WDT goes into a monitoring state.
- (4) When a pulse is not sent to the SCK pin before V_{TW} reaches $TWVREFH$ during the monitoring state, the TW pin starts discharging and WDT goes into a reset state. During the reset state, the WDO pin voltage (V_{WDO}) becomes low.
- (5) When V_{TW} is charged up to $TWVREFH$ during the reset state, the TW pin starts discharging and WDT goes into an ignoring state.
- (6) When a pulse is sent to the SCK pin before V_{TW} reaches $TWVREFH$ during the monitoring state, the TW pin starts discharging and WDT goes into an ignoring state.
- (7) When the INH pin voltage (V_{INH}) is set to low, WDT stops monitoring. So, V_{WDO} is set to high and V_{TW} is set to low.
- (8) When V_{INH} is changed from low to high, WDT goes into the ignoring state and restarts monitoring a pulse.

Delay Operation and Reset Delay Time

RESETB Pin: R5114Sxx1A/ R5114Sxx1B
DOOUT Pin: R5114xxx2C

Delay Time Operation Timing Chart

When the VOUT pin voltage (V_{OUT}) becomes higher than the reset voltage (+V_{DET}), the CD pin voltage (V_{CD}) increases as the external capacitor starts charging. The RESETB pin voltage (V_{RESETB})/ the DOOUT pin voltage (V_{DOOUT}) remains low until V_{CD} reaches the CD pin voltage threshold (V_{TCD}). When V_{CD} becomes higher than V_{TCD}, V_{RESETB} or V_{DOOUT} changes from low to high. The reset delay time (t_{RESET}) starts when the V_{OUT} becomes higher than +V_{DET} and ends when V_{DOOUT}/V_{RESETB} changes from low to high. When V_{DOOUT}/V_{RESETB} changes from low to high, the electrical charge charged in the external capacitor starts discharging. The delay time (t_{DELAY}) starts when V_{OUT} becomes lower than the detection voltage (-V_{DET}) and ends when V_{DOOUT}/V_{RESETB} changes from high to low. It is not dependent on the capacitance of the external capacitor.

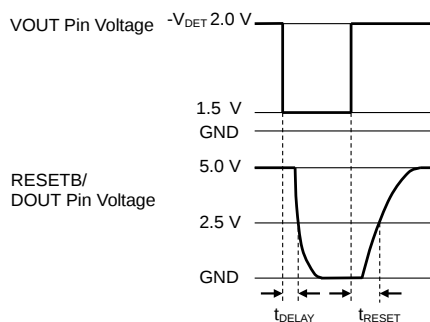
Method of Calculating the Reset Delay Time

The reset delay time (t_{RESET}) can be calculated by the following equation using an external capacitance (C_D):

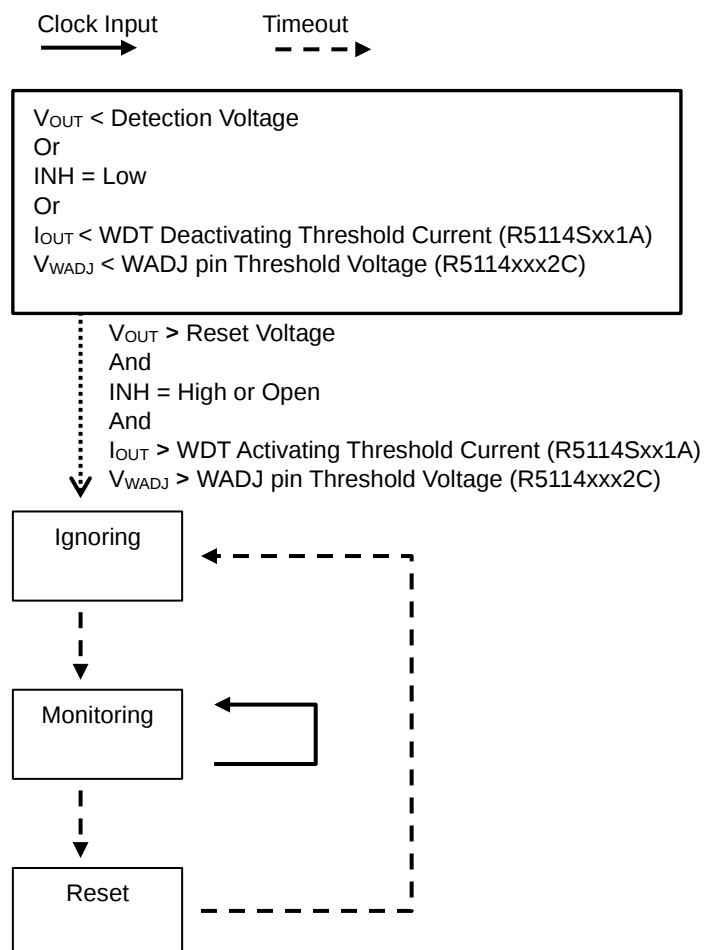
$$t_{\text{RESET}} (\text{s}) = 1.0 \times C_D (\text{F}) / (1.0 \times 10^{-6})$$

To make the VOUT/ SENSE pin voltage rises slower than 0.1 V/s, place a 100-pF or more capacitor (C_D).

t_{RESET} starts when the RESETB/DOOUT pin is pulled up to 5 V using a 100-kΩ resistor, and a 1.5-V to (-V_{DET}) + 2.0-V pulse voltage is applied to the VOUT pin. It ends when V_{OUT} reaches 2.5 V.



Watchdog Timer State Transition Diagram



Watchdog Timer Setting

A watchdog timer (t_{IGN} , t_{WD} , t_{WR}) can be set by using a capacitor connected to the TW pin. The relationships between the capacitances and the watchdog timers are described as below:

$$t_{IGN} (s) = 1.8 \times C (F) / (1.0 \times 10^{-6})$$

$$t_{WD} (s) = 1.8 \times C (F) / (1.0 \times 10^{-6})$$

$$t_{WR} (s) = 1.8 \times C (F) / (2.0 \times 10^{-6})$$

R5114x

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Standby Function

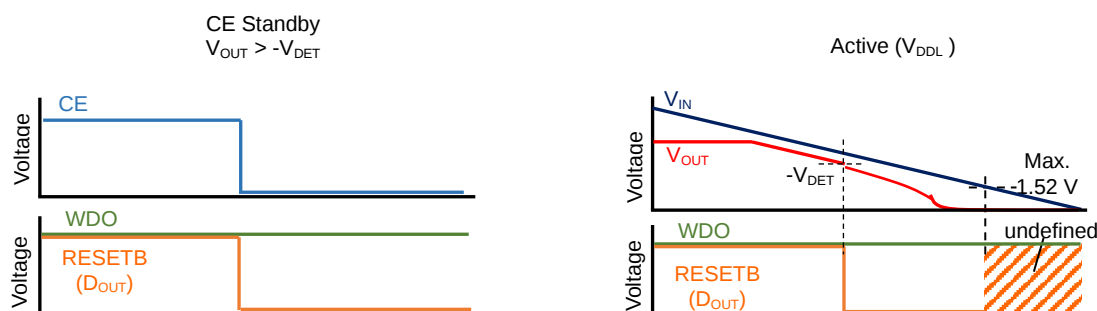
When the CE pin voltage (V_{CE}) is low, the R5114x goes into the standby mode. During the standby mode, the voltage regulator (VR) stops the output, the watchdog timer (WDT) stops the pulse monitoring and the voltage detector (VD) stops the voltage monitoring.

When V_{CE} is low, the outputs of WDT and VD will be as follows regardless of the output voltage (V_{OUT}).

R5114Sxx1A/ R5114Sxx1B: The RESETB pin voltage (V_{RESETB}) is fixed to low.

R5114xxx2C: The DOUT pin voltage (V_{DOUT}) is low and the WDO pin voltage (V_{WDO}) is fixed to the pull-up voltage.

When the input voltage (V_{IN}) is less than 1.52 V with 5-V pull-up voltage and 100-k Ω pull-up resistance, V_{RESETB}/V_{DOUT} becomes indefinite, which means 0.1 V or more.



Voltage Regulator Voltage Setting

The voltage detector (VD) detects the output voltage drop of the voltage regulator (VR). If the VD reset voltage ($+V_{DET}$) is set to higher than the VR output voltage (V_{OUT}), VD continuously sends a reset signal even if VR output voltage (V_{OUT}) returns to the normal after detecting the output voltage drop of VR. To prevent this, the following conditions have to be met.

$$(\text{VR Set Output Voltage}) \times 0.985 - 30 \text{ mV} > (\text{VD Set Detection Voltage}) \times 1.018 \times 1.030$$

When using a device that is not meeting the above conditions, careful consideration must be given to the system operation before use.

Inhibit Function

When the INH pin voltage (V_{INH}) is low, the watchdog timer (WDT) stops monitoring a pulse. The WDO pin voltage (V_{WDO}) is fixed to high. The INH pin voltage (V_{INH}) is internally pulled up with a 400-k Ω (Typ.) resistor.

WADJ Function

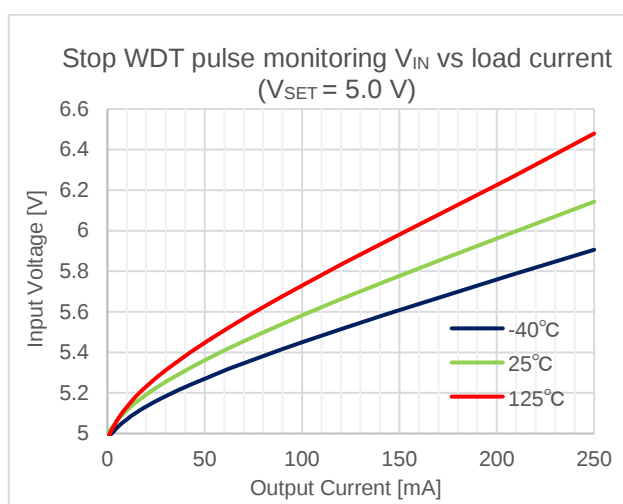
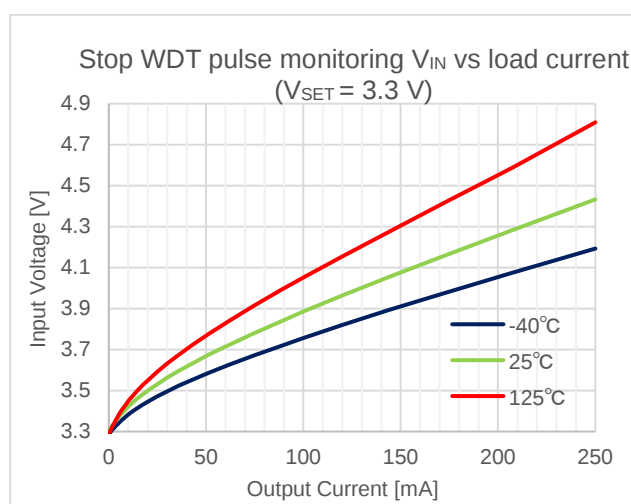
The R5114Sxx1A/ R5114xxx2C stops monitoring a pulse when the VR load current, which is a current flowing from the VOUT pin, is small. V_{WDO} is fixed to high. With the R5114Sxx1A, WDT stops monitoring a pulse when the load current is 1.0 mA (Typ.). With the R5114xxx2C, the load current can be set by using a resistor (R2) connected to the WADJ pin. The relationships between the resistance (R2) and the load current for deactivating the pulse monitoring of WDT ($I_{OWDTDEACT}$), and the resistance (R2) and the load current for activating the pulse monitoring of WDT ($I_{OWDTACT}$) are described as below.

$$I_{OWDTACT} = V_{WADJ_TH} * \frac{I_{OUT}}{I_{WADJ}} (1) / R2$$

$$I_{OWDTDEACT} = V_{WADJ_TH} * \frac{I_{OUT}}{I_{WADJ}} (2) / R2$$

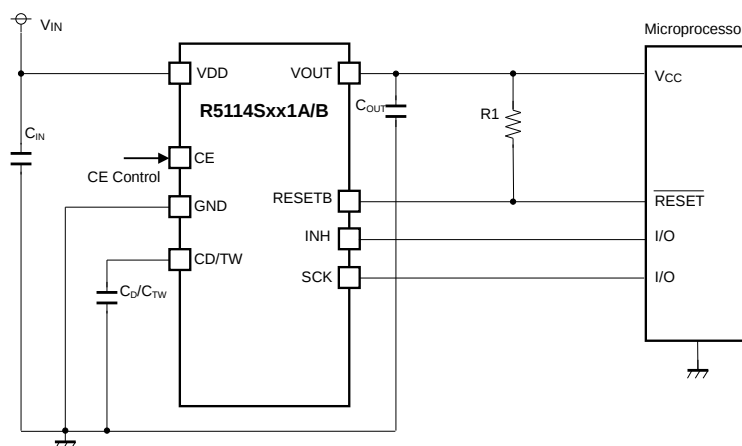
With the R5114Sxx1B, WDT monitors a pulse even when VR is in no-load state.

It is noted that WDT stops its operation regardless of load current of VR in the range of V_{IN} where the stable operation is not ensured owing to low V_{OUT} ; Dropout Voltage (V_{DIF}): $V_{IN} - V_{OUT}$ is < 1.2 V ($V_{SET} = 3.3$ V, $I_{OUT} = 100$ mA). The output voltage from RESETB pin of R5114Sxx1A depends on only VD and WDO pin of R5114xxx2C is hold as "High."

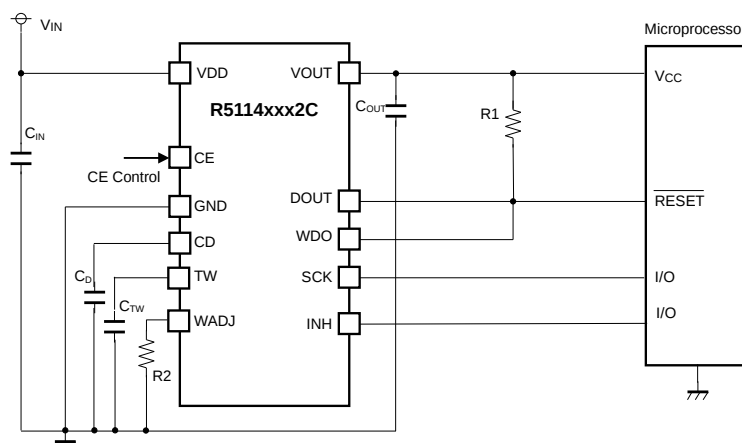


APPLICATION INFORMATION

Typical Application



R5114Sxx1A/B Typical Application Circuit



R5114xxx2C Typical Application Circuit

External Components

Symbol	Description
C _{IN}	0.1 μF, Ceramic Capacitor
C _{OUT}	0.1 μF, Ceramic Capacitor
C _{TW}	Capacitor for setting a WDT Refer to WDT Setting at Theory of Operation.
C _D	Capacitor for setting reset delay time Refer to Delay Operation and Reset Delay Time at <i>THEORY OF OPERATION</i> .
R1	Set the value for R1 considering the output current when the Nch is on and the leakage current when the Nch is off described in the Electrical Characteristics.
R2	Set the value for R2 considering the WADJ pin current ration and the WADJ pin threshold voltage described in the Electrical Characteristics.

TECHNICAL NOTES

The performance of a power source circuit using this device is highly dependent on a peripheral circuit. A peripheral component or the device mounted on PCB should not exceed its rated voltage, rated current or rated power. When designing a peripheral circuit, please be fully aware of the following points.

Phase Compensation

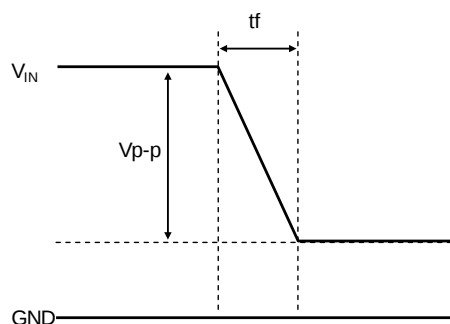
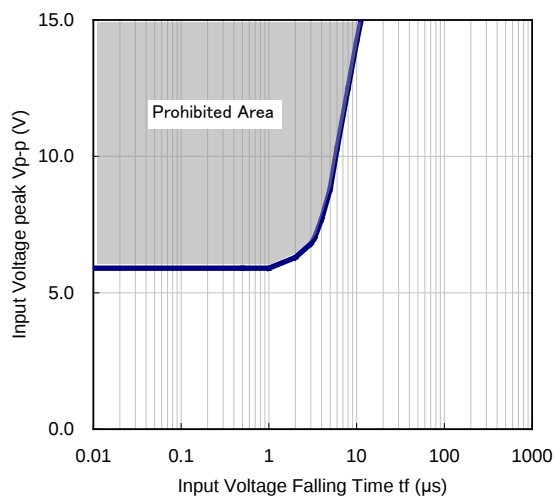
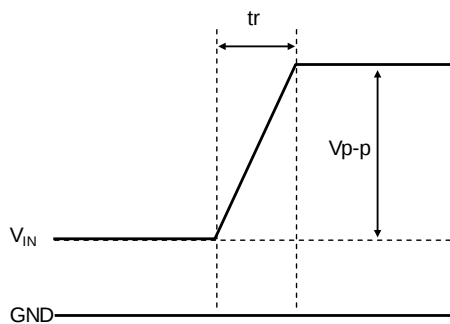
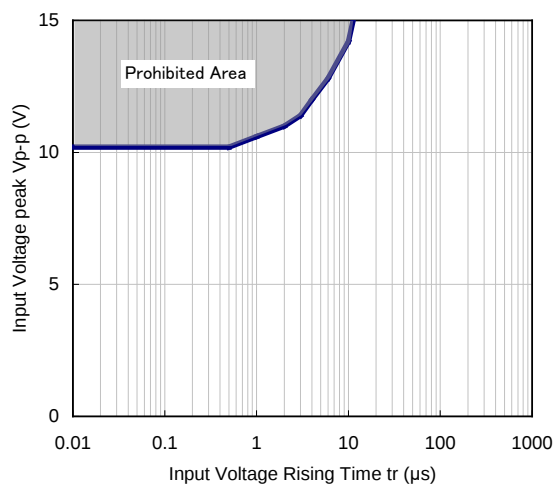
A phase compensation is provided to secure stable operation even when the load current is varied. For this purpose, use a 0.1- μ F or more output capacitor (C_{OUT}) with good frequency characteristics and proper ESR (Equivalent Series Resistance). In case of using a tantalum type capacitor with a large ESR, the output might become unstable. Evaluate your circuit including consideration of frequency characteristics. Connect a 0.1- μ F or more input capacitor (C_{IN}) between the VDD and GND pins with shortest-distance wiring.

PCB Layout

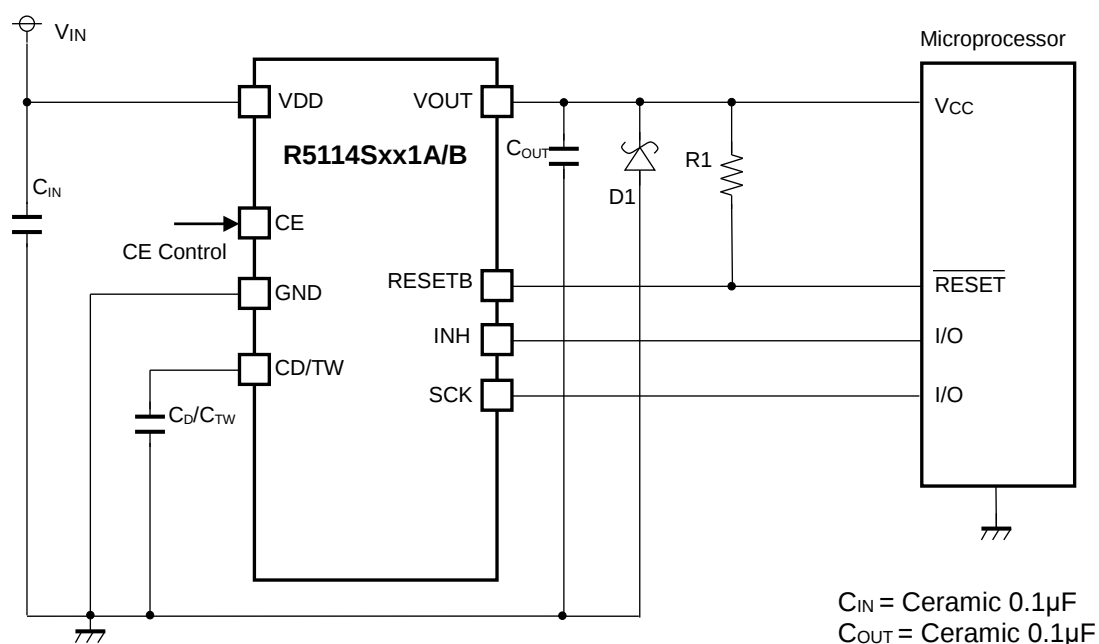
Ensure that the VDD and GND lines are sufficiently robust. If their impedances are too high, noise pickup or unstable operation may result. Connect a 1.0 μ F or more input capacitor (C_{IN}) between the VDD and GND pins with shortest-distance wiring. Also, connect an output capacitor (C_{OUT}) between the VOUT and GND pins with shortest-distance wiring.

Input Voltage Fluctuation Prohibited Area

The input voltage fluctuation in the following area may cause false detection or false detection release, so should not be allowed.

**Input Voltage Falling Fluctuation Prohibited Area****Input Voltage Rising Fluctuation Prohibited Area**

Typical Application Circuit with IC Chip Breakdown Prevention



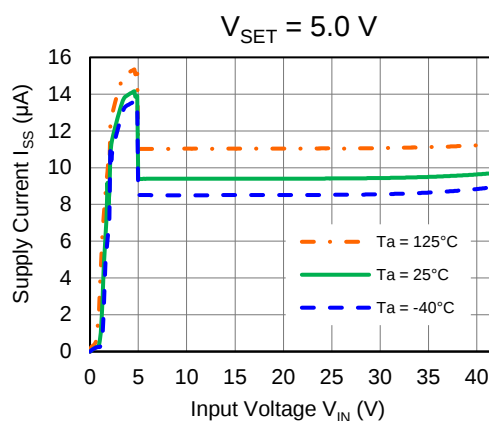
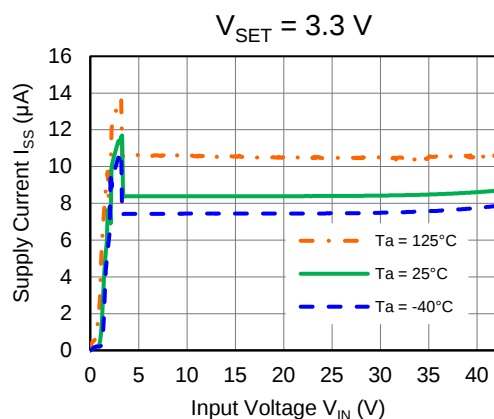
R5114Sxx1A/B Typical Application Circuit with IC Chip Breakdown Prevention

When a sudden surge of electrical current travels along the VOUT pin and GND due to a short-circuit, electrical resonance of a circuit involving an output capacitor (C_{OUT}) and a short circuit inductor generates a negative voltage and may damage the device or the load devices. Connecting a schottky diode (D1) between the VOUT pin and GND has the effect of preventing damage to them.

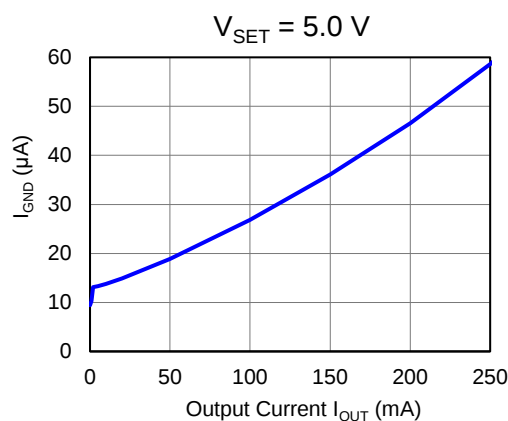
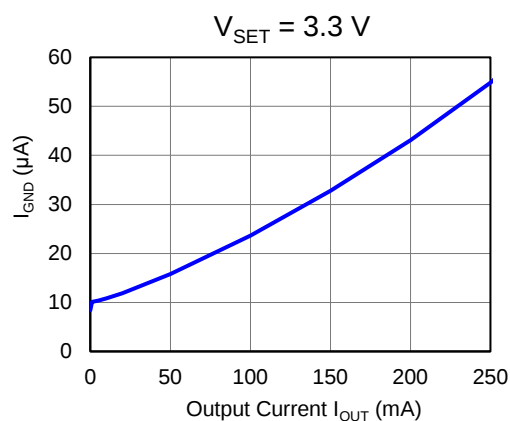
TYPICAL CHARACTERISTICS

Note: Typical Characteristics are intended to be used as reference data; they are not guaranteed.

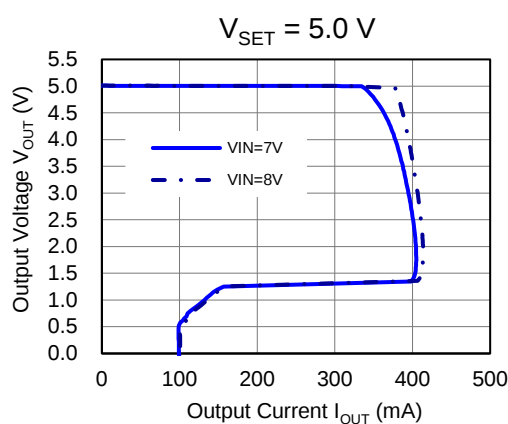
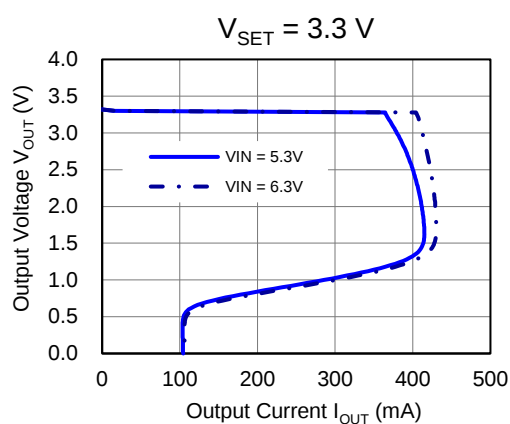
1) Supply Current vs. Input Voltage



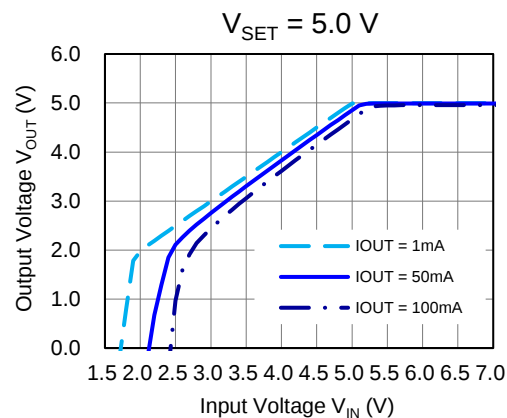
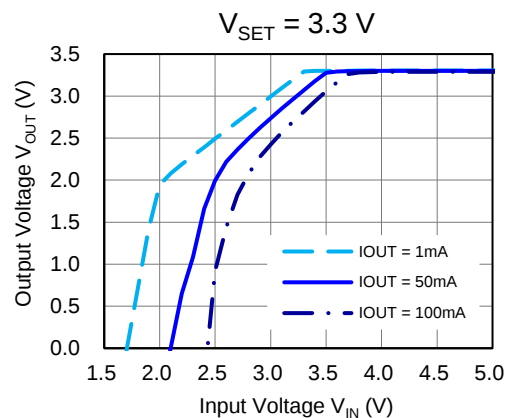
2) GND Pin Current vs. Output Current ($T_a = 25^\circ\text{C}$)



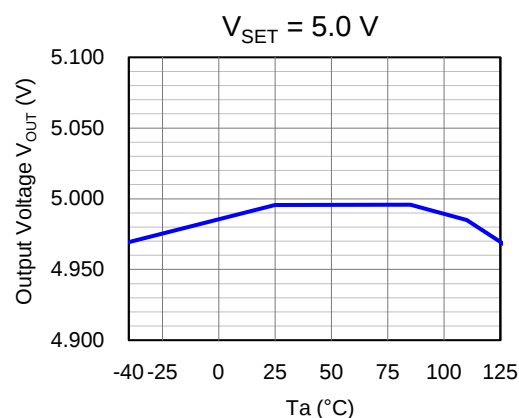
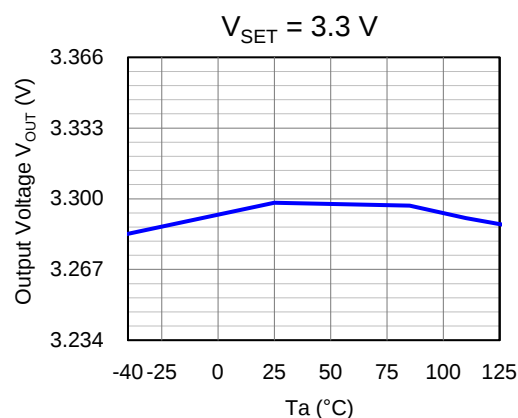
3) Output Voltage vs. Output Current ($T_a = 25^\circ\text{C}$)



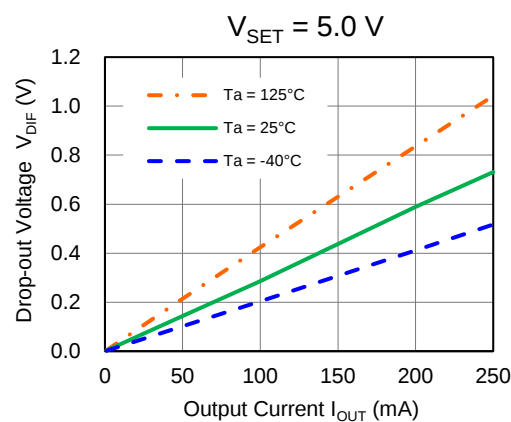
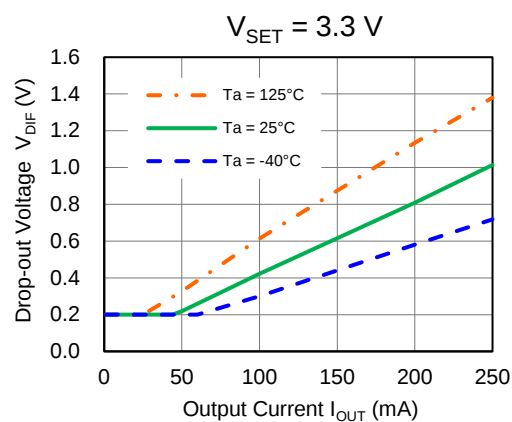
4) Output Voltage vs. Input Voltage ($T_a = 25^\circ\text{C}$)

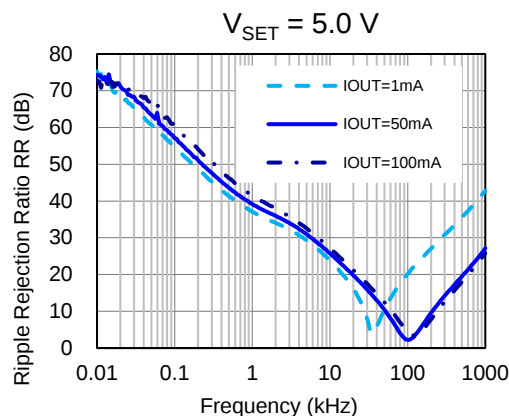
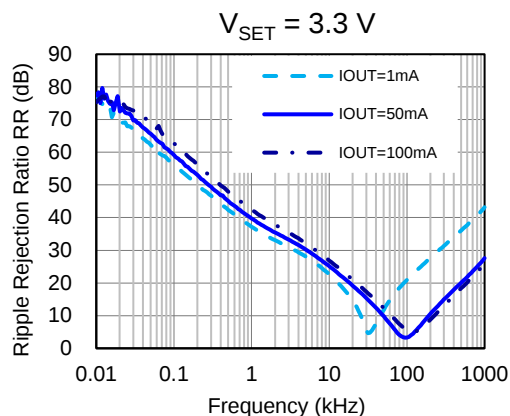
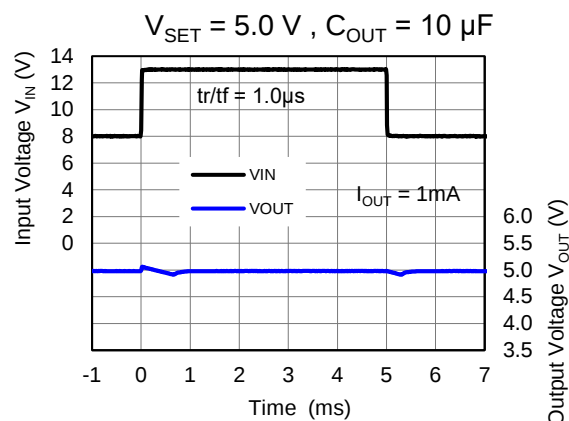
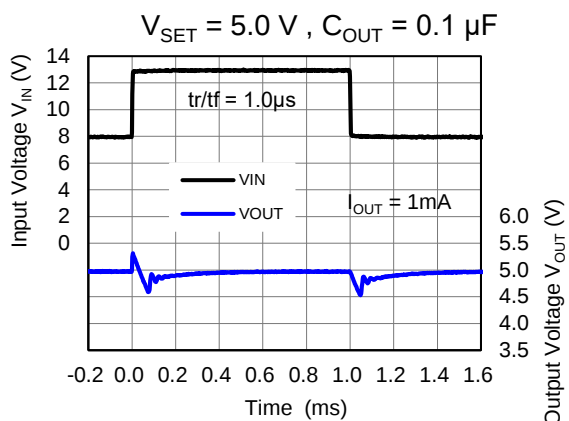
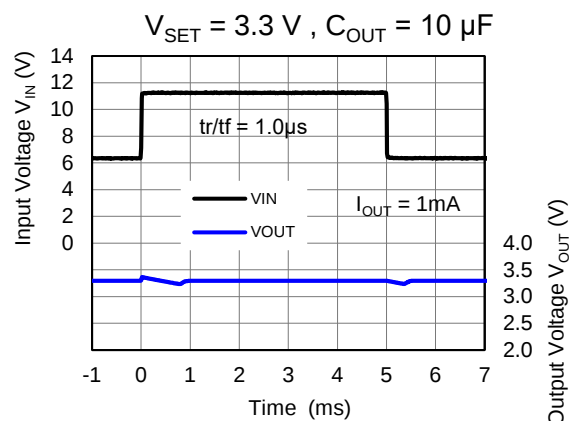
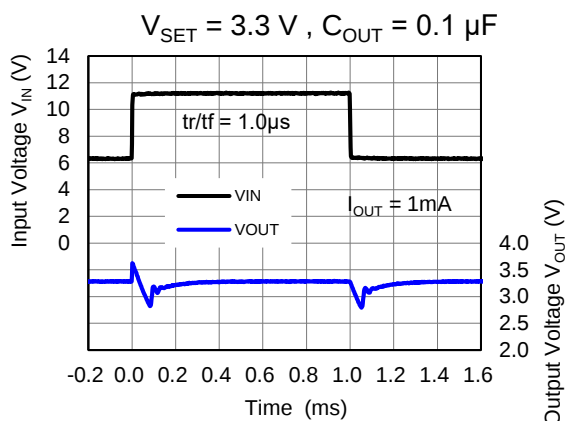


5) Output Voltage vs. Ambient Temperature ($V_{\text{IN}} = 14\text{ V}$, $I_{\text{OUT}} = 1\text{ mA}$)

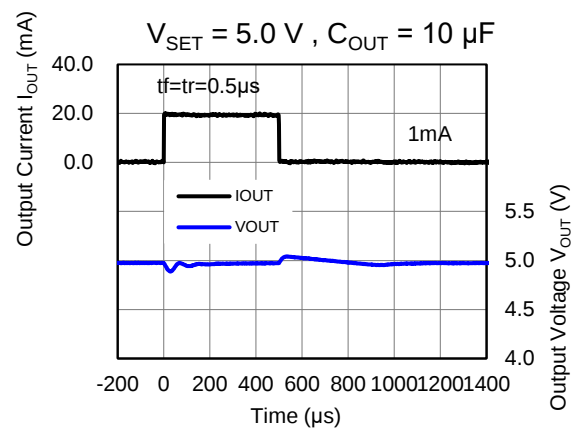
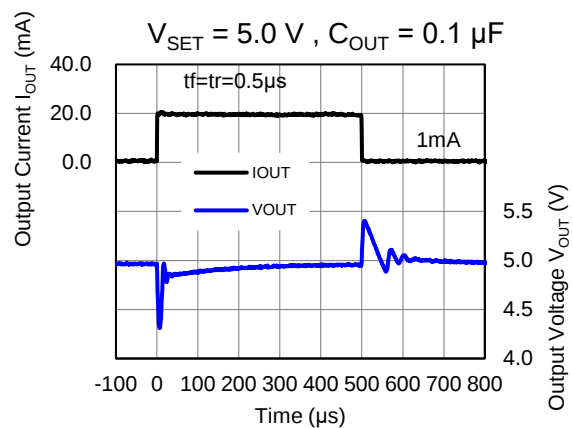
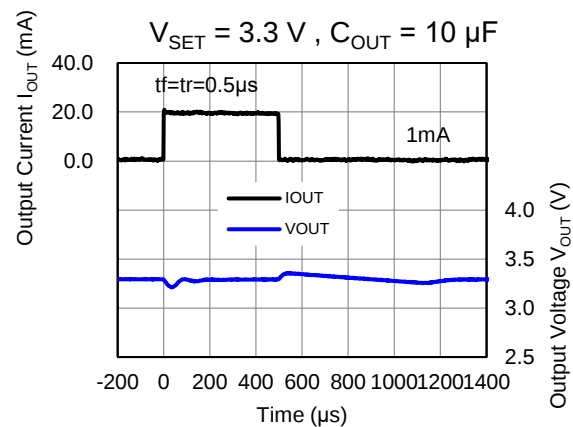
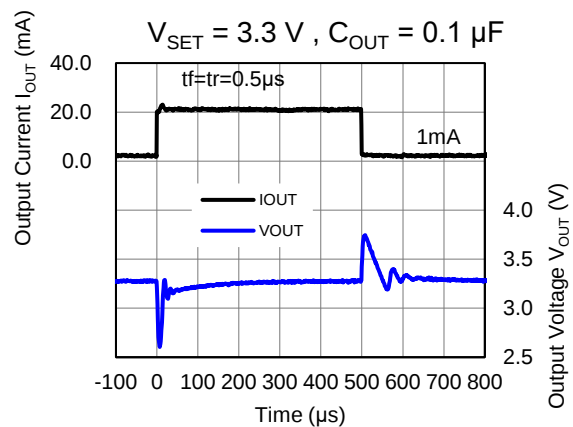


6) Dropout Voltage vs. Output Current

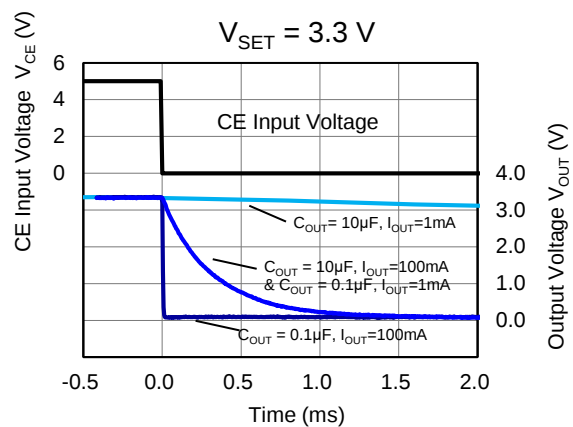
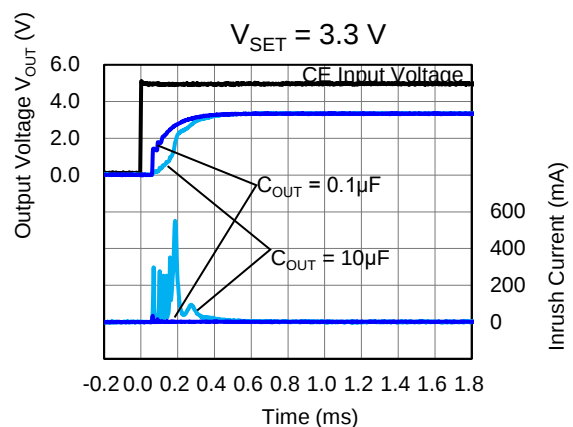


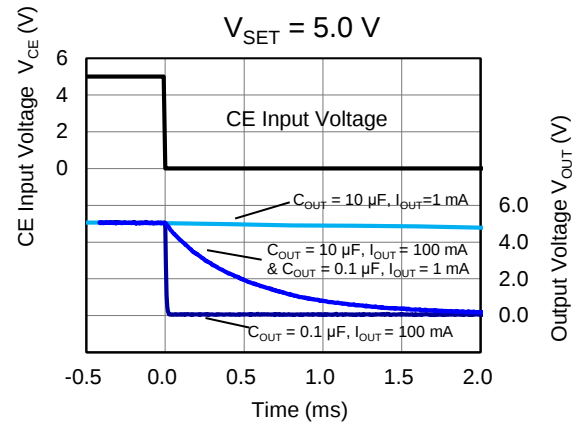
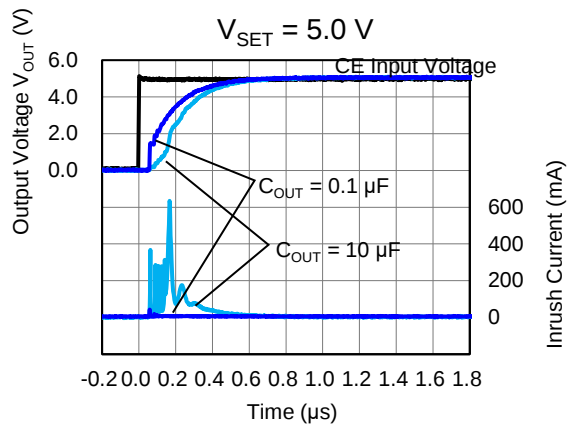
7) Ripple Rejection vs. Frequency ($T_a = 25^\circ\text{C}$, Ripple = 0.2 Vpp)

8) Input Transient Response ($T_a = 25^\circ\text{C}$)


9) Load Transient Response ($T_a = 25^\circ\text{C}$)

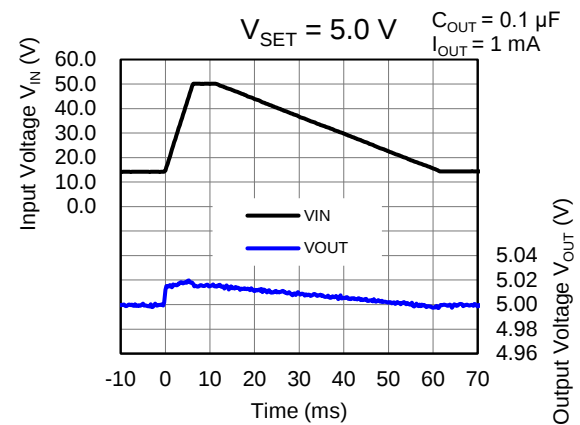
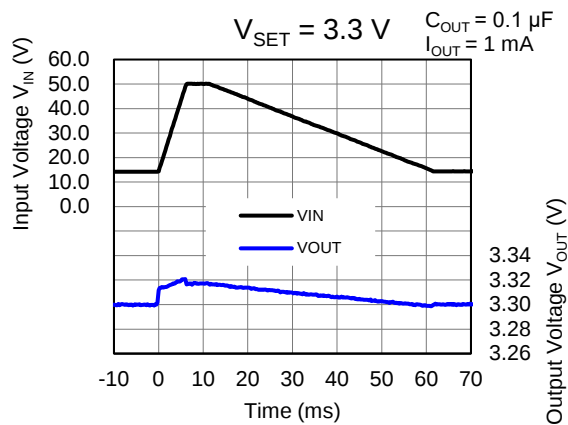


10) CE Transient Response ($T_a = 25^\circ\text{C}$, $V_{\text{IN}} = 14\text{ V}$, $I_{\text{OUT}} = 1\text{ mA}$, $C_{\text{OUT}} = 0.1\text{ }\mu\text{F}/10\text{ }\mu\text{F}$)

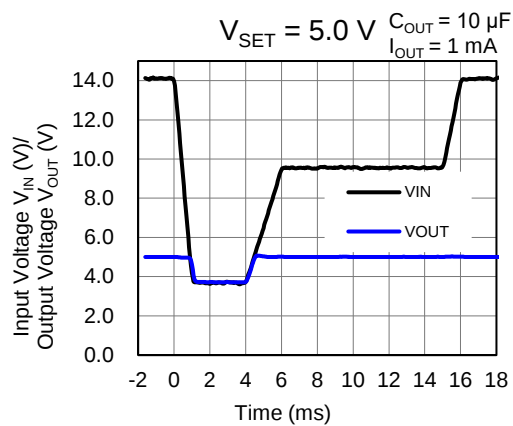




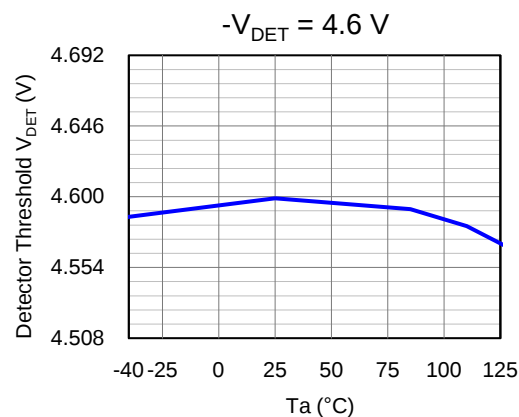
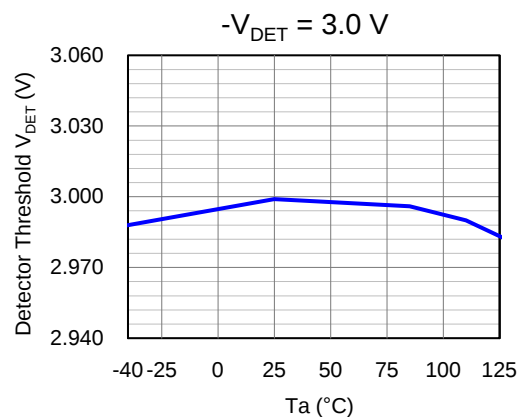
11) Load Dump ($T_a = 25^\circ\text{C}$)



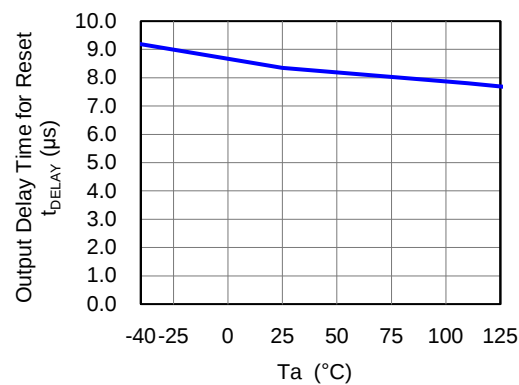
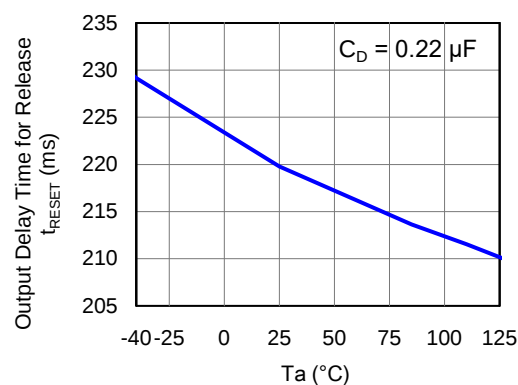
12) Cranking ($T_a = 25^\circ\text{C}$)



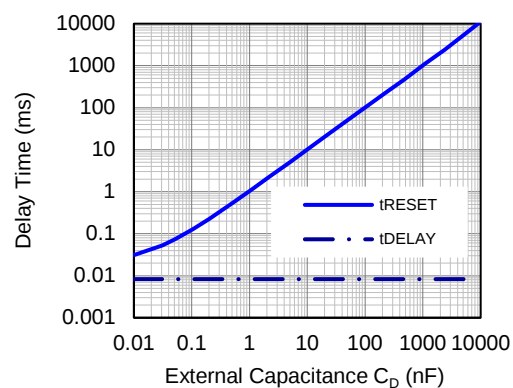
13) Detection Voltage vs. Ambient Temperature

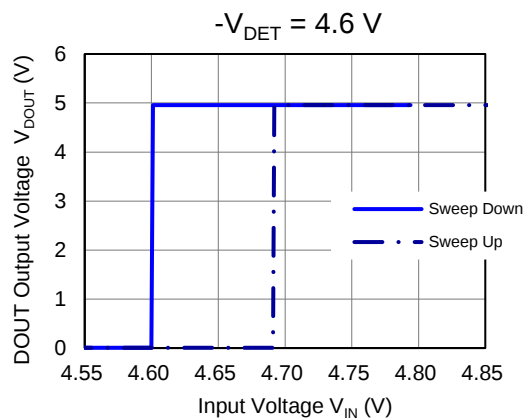
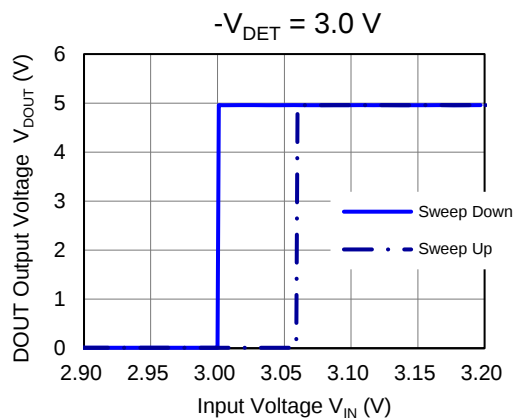
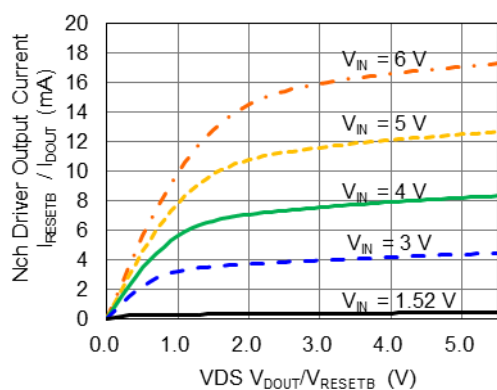
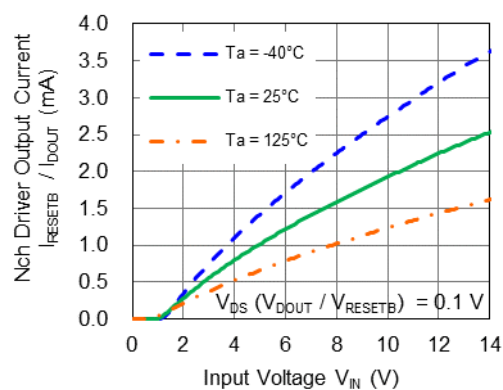
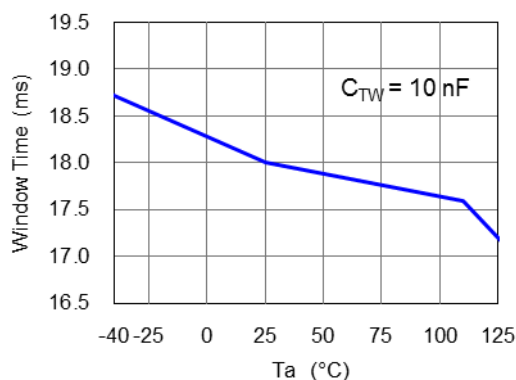
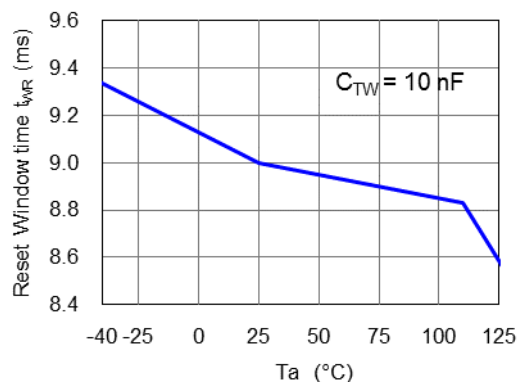


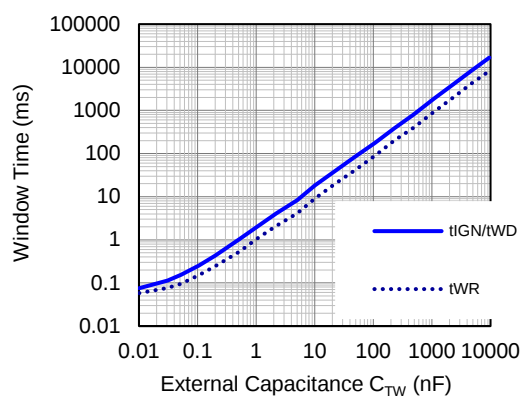
14) Release Delay Time vs. Ambient Temperature 15) Detection Delay Time vs. Ambient Temperature



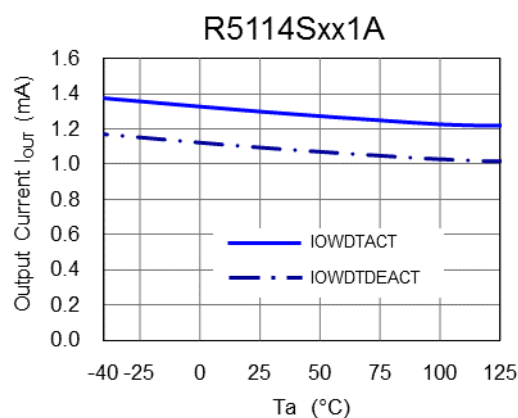
16) Release Delay and Detection Delay Time vs. CD Pin External Capacitance



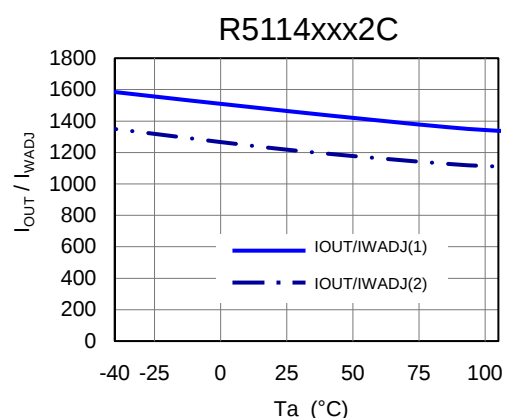
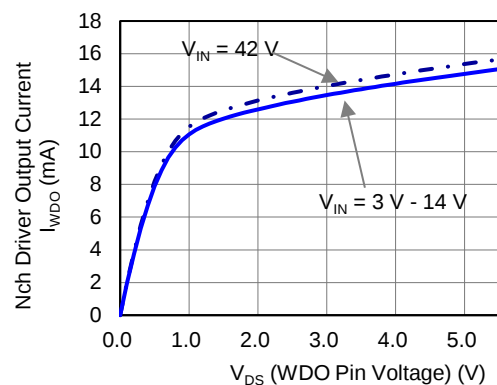
17) DOUT Pin Voltage vs. Input Voltage (DOUT pulled-up to 5 V with 100 kΩ)

18) RESETB/DOUT Driver Output Current vs. V_{DS}

19) RESETB/DOUT Driver Output Current vs. Input Voltage

20) Monitoring Time/Pulse Ignoring Time vs. Ambient Temperature

21) Reset Time vs. Ambient Temperature


22) WDT t_{WD} / t_{IGN} / t_{RST} vs. TW Pin External Capacitance

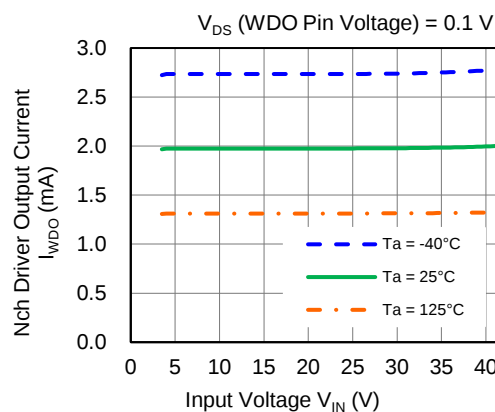
23) WDT Monitoring Threshold Load Current vs. Ambient Temperature



24) WADJ Pin Current Ratio vs. Ambient Temperature

25) WDO Driver Output Current vs. V_{DS} 

26) WDO Driver Output Current vs. Input Voltage



The power dissipation of the package is dependent on PCB material, layout, and environmental conditions. The following measurement conditions are based on JEDEC STD. 51-7.

Measurement Conditions

Item	Measurement Conditions
Environment	Mounting on Board (Wind Velocity = 0 m/s)
Board Material	Glass Cloth Epoxy Plastic (Four-Layer Board)
Board Dimensions	76.2 mm × 114.3 mm × 0.8 mm
Copper Ratio	Outer Layer (First Layer): Less than 95% of 50 mm Square Inner Layers (Second and Third Layers): Approx. 100% of 50 mm Square Outer Layer (Fourth Layer): Approx. 100% of 50 mm Square
Through-holes	φ 0.3 mm × 21 pcs

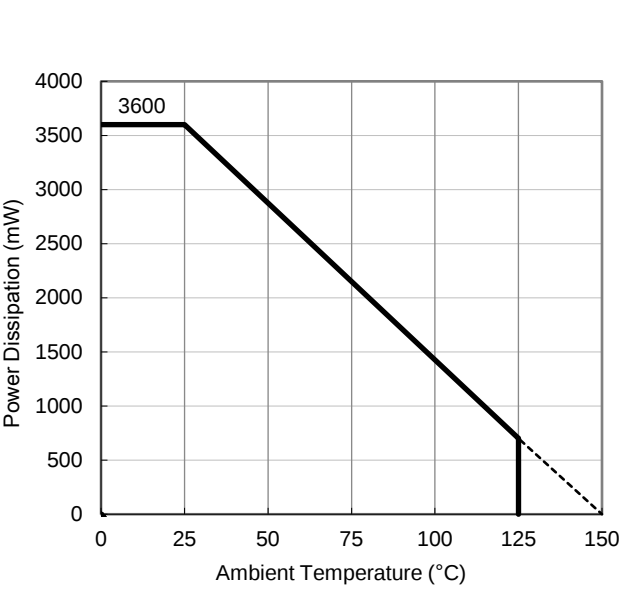
Measurement Result

(Ta = 25°C, Tjmax = 150°C)

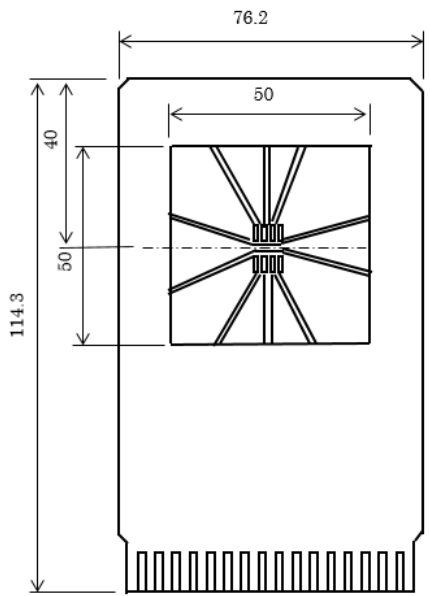
Item	Measurement Result
Power Dissipation	3600 mW
Thermal Resistance (θja)	θja = 34.5°C/W
Thermal Characterization Parameter (ψjt)	ψjt = 10°C/W

θja: Junction-to-Ambient Thermal Resistance

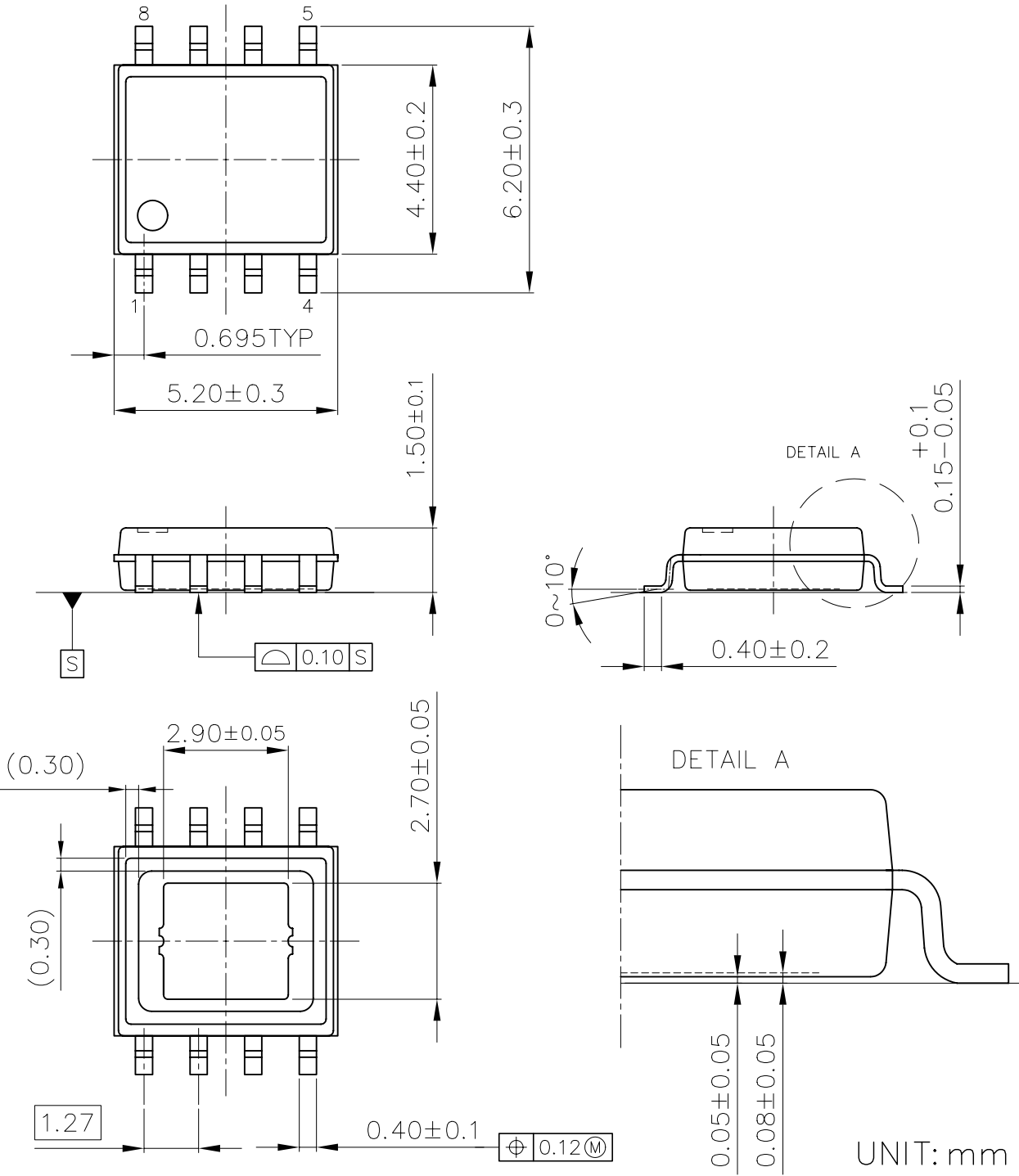
ψjt: Junction-to-Top Thermal Characterization Parameter



Power Dissipation vs. Ambient Temperature



Measurement Board Pattern



HSOP-8E Package Dimensions

The power dissipation of the package is dependent on PCB material, layout, and environmental conditions. The following measurement conditions are based on JEDEC STD. 51-7.

Measurement Conditions

Item	Measurement Conditions
Environment	Mounting on Board (Wind Velocity = 0 m/s)
Board Material	Glass Cloth Epoxy Plastic (Four-Layer Board)
Board Dimensions	76.2 mm × 114.3 mm × 0.8 mm
Copper Ratio	Outer Layer (First Layer): Less than 95% of 50 mm Square Inner Layers (Second and Third Layers): Approx. 100% of 50 mm Square Outer Layer (Fourth Layer): Approx. 100% of 50 mm Square
Through-holes	φ 0.3 mm × 21 pcs

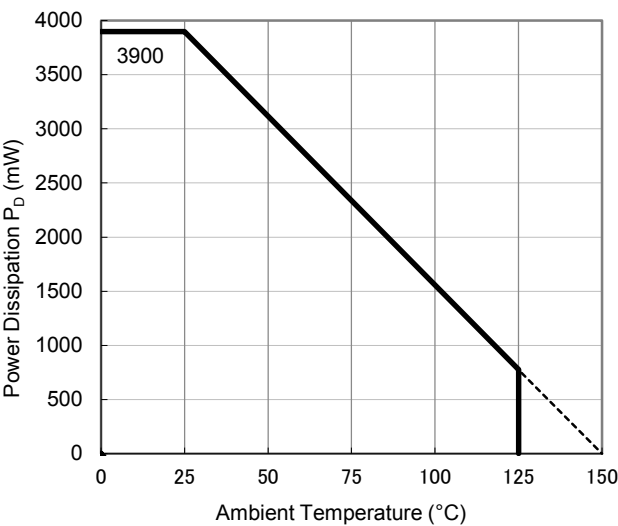
Measurement Result

(Ta = 25°C, Tjmax = 150°C)

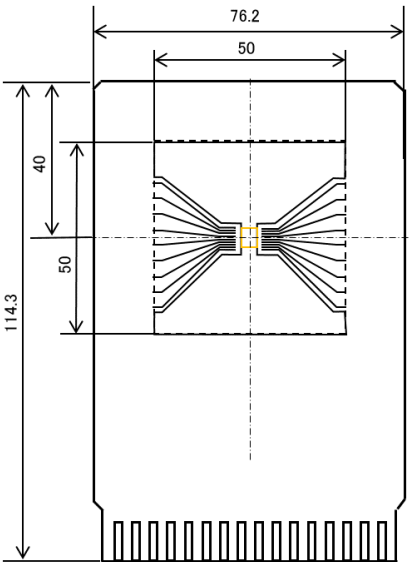
Item	Measurement Result
Power Dissipation	3900 mW
Thermal Resistance (θja)	θja = 32°C/W
Thermal Characterization Parameter (ψjt)	ψjt = 8°C/W

θja: Junction-to-Ambient Thermal Resistance

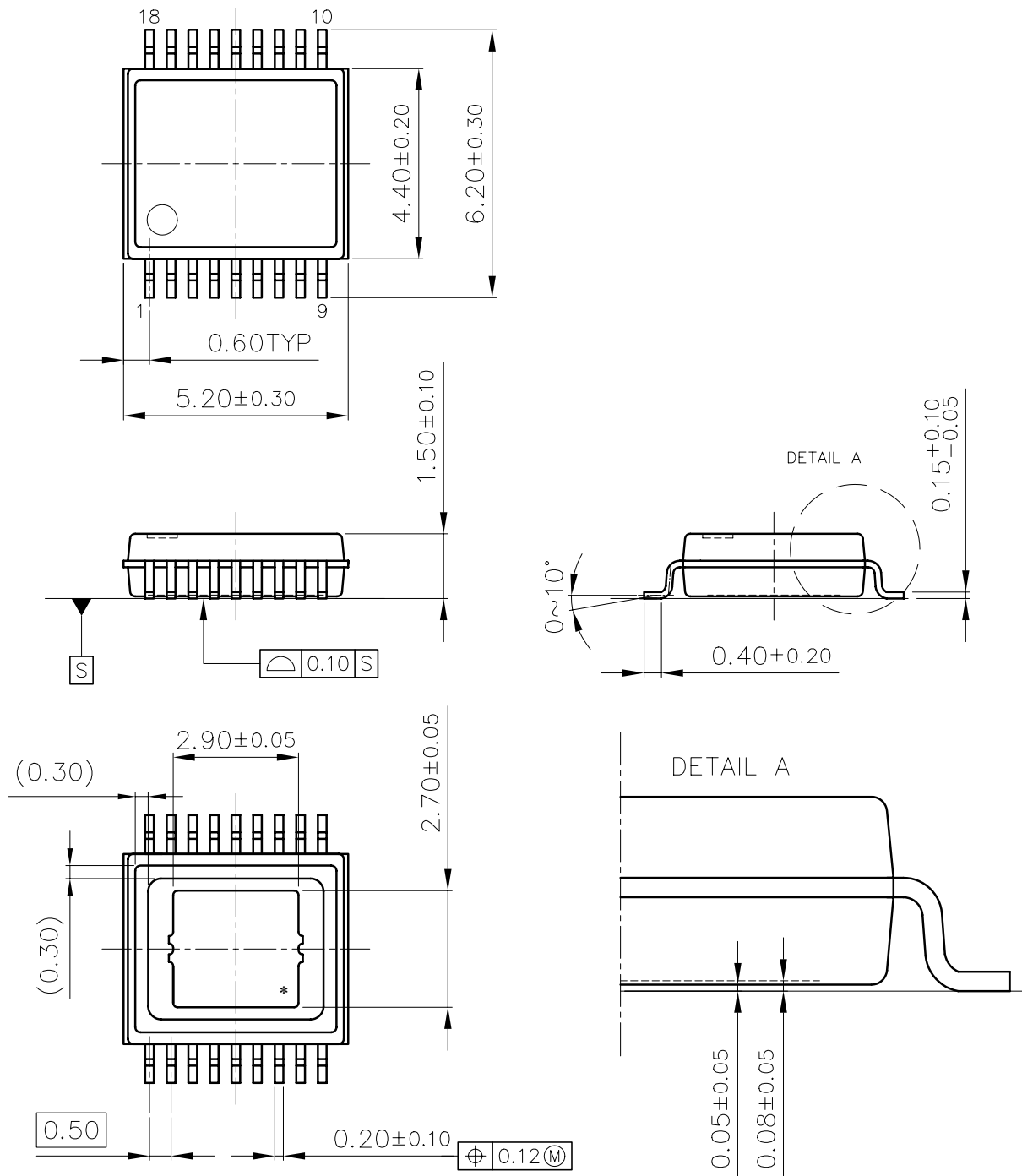
ψjt: Junction-to-Top Thermal Characterization Parameter



Power Dissipation vs. Ambient Temperature



Measurement Board Pattern



HSOP-18 Package Dimensions

The power dissipation of the package is dependent on PCB material, layout, and environmental conditions. The following measurement conditions are based on JEDEC STD. 51-7.

Measurement Conditions

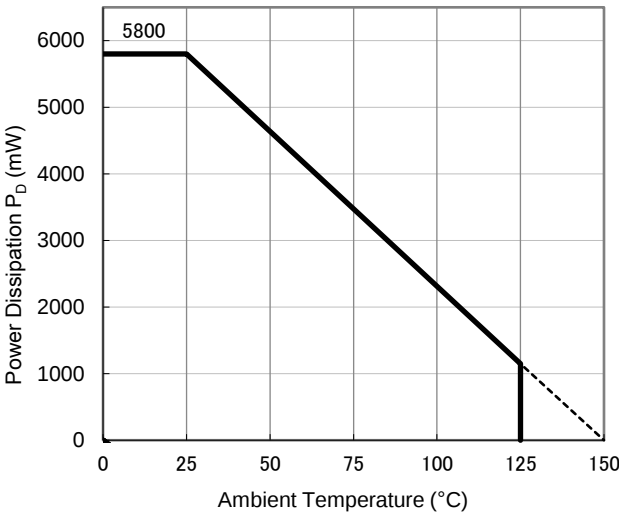
Item	Measurement Conditions
Environment	Mounting on Board (Wind Velocity = 0 m/s)
Board Material	Glass Cloth Epoxy Plastic (Four-Layer Board)
Board Dimensions	76.2 mm × 114.3 mm × 0.8 mm
Copper Ratio	Outer Layer (First Layer): Less than 95% of 50 mm Square Inner Layers (Second and Third Layers): Approx. 100% of 50 mm Square Outer Layer (Fourth Layer): Approx. 100% of 50 mm Square
Through-holes	φ 0.3 mm × 72 pcs

Measurement Result

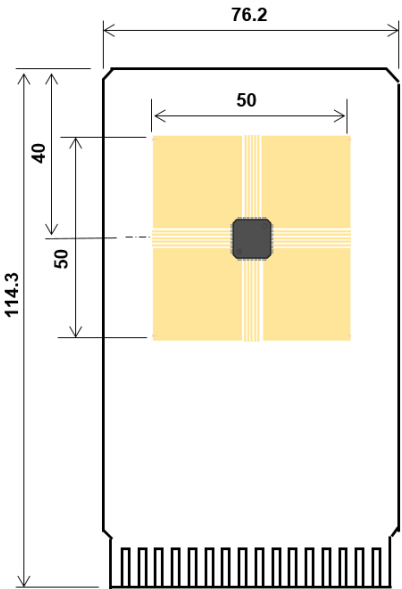
(Ta = 25°C, Tjmax = 150°C)

Item	Measurement Result
Power Dissipation	5800 mW
Thermal Resistance (θja)	θja = 21.5°C/W
Thermal Characterization Parameter (ψjt)	ψjt = 5°C/W

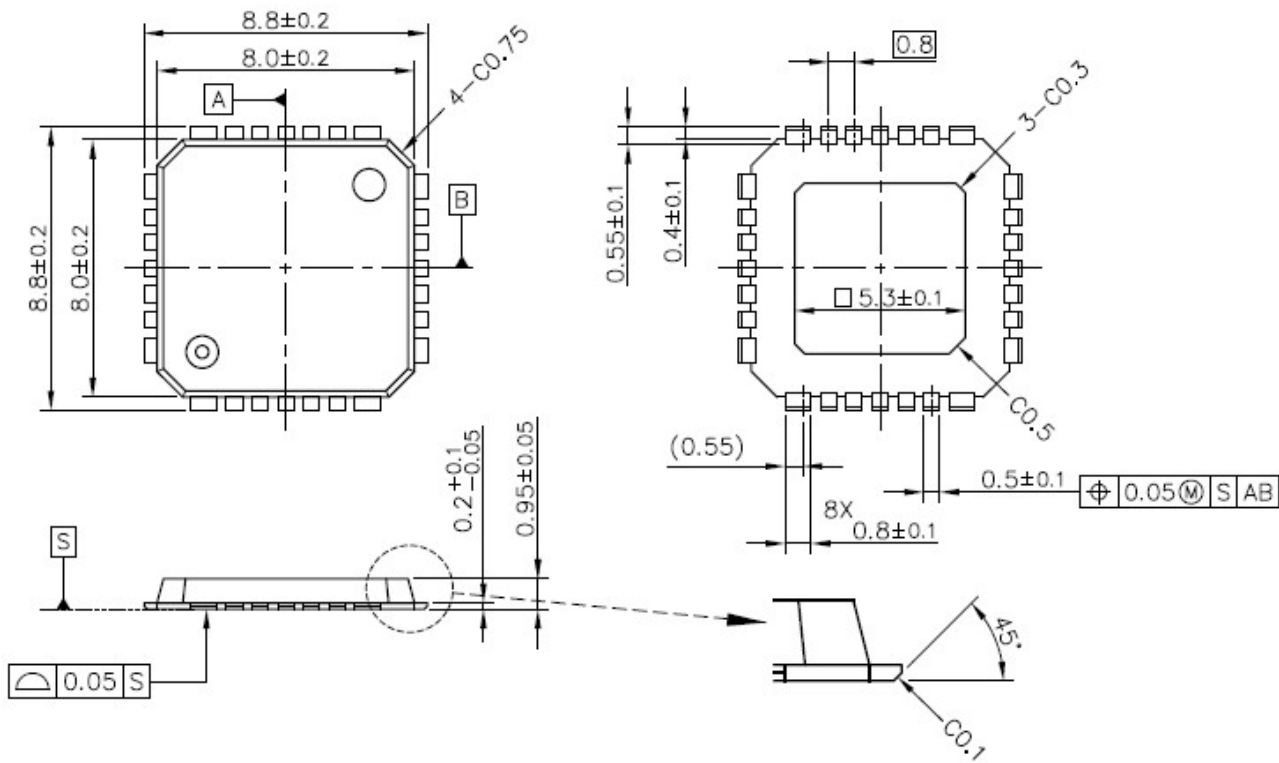
θja: Junction-to-ambient thermal resistance.
ψjt: Junction-to-top of package thermal characterization parameter



Power Dissipation vs. Ambient Temperature



Measurement Board Pattern



UNIT: mm

HQFN0808-28 Package Dimensions



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7. Anti-radiation design is not implemented in the products described in this document.
8. The X-ray exposure can influence functions and characteristics of the products. Confirm the product functions and characteristics in the evaluation stage.
9. WLCSP products should be used in light shielded environments. The light exposure can influence functions and characteristics of the products under operation or storage.
10. There can be variation in the marking when different AOI (Automated Optical Inspection) equipment is used.
In the case of recognizing the marking characteristic with AOI, please contact Ricoh sales or our distributor before attempting to use AOI.
11. Please contact Ricoh sales representatives should you have any questions or comments concerning the products or the technical information.



Ricoh is committed to reducing the environmental loading materials in electrical devices with a view to contributing to the protection of human health and the environment.

Ricoh has been providing RoHS compliant products since April 1, 2006 and Halogen-free products since April 1, 2012.

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